Overview

Important Note: Features and Supported Configurations will differ between the Z4 G4 Workstations with Intel® Xeon®W Processors and the Z4 G4 Workstation with Intel® Core™ X Processors. Where different – features are shown side by side. Supported configurations are indicated by the CPU Support references.

HP Z4 G4 Workstation



Front view

- 1. Front I/O module options
 - Premium (optional): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C[™], Headset audio, SD Card Reader (optional) (Left-most Type-A port has charging capability)
 - Standard (shown here): power button, 4 USB 3.1 G1 Type-A (left-most Type-A port has charging capability), Headset audio, SD Card Reader (optional)
- 2. Front handle
- 3. 2 x 5.25" external drive bays



Overview



Intel[®] Xeon[®] W Processors

Intel® Xeon® Processors: W-2100 family

2 PCIe G3 x16, 2 PCIe G3 x4, 1 PCIe G3 x8



Internal view

Intel[®] Core™ X-series Processors

- Intel[®] Core [™] i7-X-series processors Intel[®] Core [™] i9-X Series processors Intel[®] Core [™] i9 Extreme Edition processor
 - Core i9-X configs/Core i7 9800X: 2 PCIe G3 x16, 2 PCIe G3 x4, 1 PCIe G3 x8 Other Core i7-X configs: 1 PCIe G3 x16, 1 PCIe G3 x16 (x8 electrical), 2 PCIe G3 x4, 1 PCIe G3 x8 (mechanical only)
 - 6. 1 PCIe G3 x4 M.2 for SSDs
 - 7. 8 DIMM slots: DDR4-2666 Non-ECC Unbuffered RAM
 - 8. PSU:
 - 1000W 90% efficient with up to 4 graphics power Adapters

7. 8 DIMM slots; DDR4-2666 ECC Registered RAM

2 PCIe G3 x4 M.2 for SSDs

- 8. PSU options:
 - 465W 90% efficient with 0 graphics power adapters
 - 750W 90% efficient with 2 graphics power adapters
 - 1000W 90% efficient with up to 4 graphics power Adapters
 - 2 x 5.25" external drive bays
 - 2 x 2.5"/3.5" internal drive bays
 - Front card guide and fan (select configurations)
 - 6 x 6Gb/s SATA ports

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12.



Overview



Intel[®] Xeon[®] W Processors



Rear view

Intel[®] Core[™] X-series Processors

Rear power button Rear handle

Padlock loop

Kensington lock slot

17. Rear I/O (top to bottom):

_

- Audio in/out,
- Keyboard/Mouse PS/2
- USB: 5 USB 3.1 G1 Type-A
- 1x 1GbE port

Side panel barrel keylock (optional)

18.

13.

14.

15.

16.

17. Rear I/O (top to bottom):

_

Audio in/out,

2x 1GbE ports

Keyboard/Mouse PS/2

USB: 6 USB 3.1 G1 Type-A



HP Z4 G4 Workstation

Supported Components

Overview

Form Factor Operating Systems

Minitower

Intel[®] Xeon[®] W Processors

Preinstalled:

- Windows 10 Pro 64 for Workstations*
- Windows 10 Pro 64 Downgrade to Windows 7 64/ 64 Plus **
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat[®] Enterprise Linux[®] Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat[®] Enterprise Linux[®] Desktop 7.4
- SUSE Linux[®] Enterprise Desktop 12 SP3
- Ubuntu 16.04.3 LTS

Notes: For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

Intel[®] Core™ X-series Processors Preinstalled:

- Windows 10 Pro 64*
- Windows 10 Pro High End
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat[®] Enterprise Linux[®] Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat[®] Enterprise Linux[®] Desktop 7.4
- SUSE Linux[®] Enterprise Desktop 12 SP3
- Ubuntu 16.04 LTS

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

Note: In accordance with Microsoft's support policy, HP does not support the Windows[®] 8 or Windows[®] 7 operating system on products configured with Intel[®] and AMD 7th Generation and forward processors or provide any Windows[®] 8 or Windows[®] 7 drivers on http://www.support.hp.com

**only available in China through June 2019.

Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	ECC memory support	Max memory support	Hyper- Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology 2.0 (GHz) ¹	Intel® Turbo Boost Max Technology 3.0 (GHz) ²	TDP (W)
					Intel® Xe	on® W Proc	essors				
Intel [®] Xeon [®] W-2195 processor	18	2.3	24.75	2666	YES	512GB	YES	YES	3.2, 4.3	N/A	140
Intel [®] Xeon [®] W-2175 processor	14	2.5	19.25	2666	YES	512GB	YES	YES	3.3, 4.3	N/A	140
Intel [®] Xeon [®] W-2155 processor	10	3.3	13.75	2666	YES	512GB	YES	YES	4.0, 4.5	N/A	140
Intel [®] Xeon [®] W-2145 processor	8	3.7	11.00	2666	YES	512GB	YES	YES	4.3, 4.5	N/A	140
Intel [®] Xeon [®] W-2135 processor	6	3.7	8.25	2666	YES	512GB	YES	YES	4.4, 4.5	N/A	140
Intel [®] Xeon [®] W-2133 processor	6	3.6	8.25	2666	YES	512GB	YES	YES	3.8, 3.9	N/A	140

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1. 2019



Supported Components

Intel [®] Xeon [®] W-2125 processor	4	4.0	8.25	2666	YES	512GB	YES	YES	4.4, 4.5	N/A	120
Intel [®] Xeon [®] W-2123 processor	4	3.6	8.25	2666	YES	512GB	YES	YES	3.7, 3.9	N/A	120
Intel [®] Xeon [®] W-2104 processor	4	3.2	8.25	2400	YES	512GB	NO	YES	N/A	N/A	120
Intel [®] Xeon [®] W-2102 processor	4	2.9	8.25	2400	YES	512GB	NO	YES	N/A	N/A	120
				Int	el® Core™	X-Series P	rocessors				
Intel [®] Core™ i9-9980XE processor	18	3.0	24.75	2666	NO	128GB	YES	NO	4.4	4.5	165
Intel [®] Core™ i9-9920X processor	12	3.5	19.25	2666	NO	128GB	YES	NO	4.4	4.5	165
Intel [®] Core™ i9-9820X processor	10	3.3	16.5	2666	NO	128GB	YES	NO	4.1	4.2	165
Intel [®] Core™ i7-9800X processor	8	3.8	16.5	2666	NO	128GB	YES	NO	4.4	4.5	165
Intel [®] Core™ i9-7980XE processor	18	2.6	24.75	2666	NO	128GB	YES	NO	4.2	4.4	165
Intel [®] Core™ i9-7960X processor	16	2.8	22.0	2666	NO	128GB	YES	NO	4.2	4.4	165
Intel [®] Core™ i9-7940X processor	14	3.1	19.25	2666	NO	128GB	YES	NO	4.3	4.4	165
Intel [®] Core™ i9-7920X processor	12	2.9	16.5	2666	NO	128GB	YES	NO	4.3	4.4	140
Intel [®] Core™ i9-7900X processor	10	3.3	13.75	2666	NO	128GB	YES	NO	4.3	4.5	140
Intel [®] Core™ i7-7820X processor	8	3.6	11.0	2666	NO	128GB	YES	NO	4.3	4.5	140
Intel [®] Core™ i7-7800X processor	6	3.5	8.25	2400	NO	128GB	YES	NO	4.0	N/A	140
	maxim For Int freque 2Intel 1 increas Boost	um turb el® Core ncy. Furbo Bo sed perfe Max Tecl	o freque ™ proce post Max ormance hnology	ency, sin ssors, th Techno e on thos 3.0 freq	gle core ne specifi logy 3.0 se cores l juency is	maximum cations sho identifies t by taking a the clock f	turbo freq own in this he best pe dvantage requency (uency). column refe rforming con of power and	represent the er to single con re(s) on a proc d thermal head hen running ir ed as N/A.	re maximum t essor and pro droom. Intel®	turbo ovides
Available Processors											
Disclaimers	M Si fr Ci P	oftware equency onfigura erforma	applicat / will vai tions. In	ions will: ry depen	necessa ding on a	rily benefi application	t from use workload	of this techr and your ha	roducts. Not a nology. Perfor rdware and sc measurement	mance and cl oftware	
Color	В	lack									
Convertibility	Ν	0									
-			Intel®	Xeon®	W Proces	sors		intel® (Core™ X-serie	s Processors	

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

Supported Components

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Expansion Slots (see system board section for more details)	pard section for Slot 1: PCI Express Gen3 x16 (from CPU)				
	Slot 3:	Slot 3:			
	PCI Express Gen3 x16 (from CPU)	Core i9-X and Core i7-9800X configs: PCI Express Gen3 x16 (from CPU)			
		Other Core i7-X configs: PCI Express Gen3 x16(mechanical) x8(electrical) (from CPU)			
	Slot 4: PCI Express Gen3 x4 (from PCH) with open-	-ended connector*			
	Slot 5: PCI Express Gen3 x8 (from CPU) with open-ended connector*	 Slot 5: Core i9-X and Core i7-9800X configs: PCI Express Gen3 x8 (from CPU) with open-ended connector* Other Core i7-X configs: PCI Express Gen3 x8 (mechanical-only, no data) with open-ended connector* 			
	M.2 Slot 1: M.2 PCIe Gen 3 x4 (from CPU) up to 80				
	M.2 Slot 2: M.2 PCIe Gen 3 x4 (from CPU) up to 80mm storage devices	M.2 Slot 2: No 2nd M.2 connector/slot available			
	* Open-ended connector allows a greater bandwic lower bandwidth connector/slot.	Ith (e.g. x16) card to be installed physically into a			
Expansion Bays (see storage section for more details)	e section for more available.				
	• 3rd and 4th 2.5" HDD/SSD occupy a single	e external bay within a 2:1 carrier			
Front I/O	charging)), 1 Headset audio port, 4 USB 3.1 G1 Type A (1			
	 Premium (optional): Power button with p port, 2 USB 3.1 G1 Type-A (1 charging), 2 Optional: SD reader 	ower/fault LED, Drive activity LED, 1 Headset audio USB 3.1 G2 Type-C™			
Internal I/O	1 USB 3.1 G1 single-port header, 1 USB 2.0 single-	port header and 1 USB 2.0 dual-port header			
Rear I/O	Intel® Xeon® W Processor Family 6x USB 3.1 G1 Type-A 2x 1GbE LAN ports (1x supporting Intel AMT)	Intel® Core™ X- Series Processor Family 5x USB 3.1 G1 Type-A 1x 1GbE LAN ports			
	Audio: 1 Line out, 1 Line in (Line in can be retasked keyboard port, 1 Rear power button Optional: 1 serial port (cable up to rear bulkhead),	• • • •			
Interfaces Supported	SD card reader (optional) 6-channel SATA interface (6 @ 6.0 Gb/s) 6 channels are eSATA configurable for use with eS supported) Thunderbolt 3 (optional) USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (op	SATA CTO/AMO Kit (No hot plug / hot swap			
On-board RAID Support	SATA RAID 0 Striped Array Configuration SATA RAID 1 Mirrored Array Configuration SATA RAID 5 Striped/Parity Configuration				

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

Supported Components

	SATA RAID) 10 Striped/Mirrored Configuration
Chassis Dimensions (H x W x D)	H: 15.2" (3 W: 6.65" (⁷ D: 17.5" (4	386mm) 169mm)
Packaged Dimensions	H: 22.5" (5 W: 12.4" (1 D: 22.2" (5	314mm)
Rack Dimensions	4U	
Weight	Minimum: Standard:	ghts depend upon configuration (System weight only). 10.2 kg (22.4 lbs.) 11.3 kg (24.9 lbs.) : 17.3 kg (38.2 lbs.)
Temperature	Operating Above 152 for every 3 Maximum	ating: -40° to 60° C (-40° to 140° F) : 5° to 35° C (40° to 95° F) 24 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) 305 m (1,000 feet) increase in elevation rate of change: 10 °C/hr sustained sunlight
Humidity	• •	: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb ating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb
Maximum Altitude (non- pressurized)	Operating Non-opera	(with Rotational Hard Drives): 3,048 m (10,000 feet) (with only Solid-State Drives): 5,000 m (16,404 feet) ating: 12,192 m (40,000 feet) operating temperature is reduced as altitude increases. See Temperature for details.
Power Supply	Processo Support	
	xw	ENTRY 465 watts wide-ranging, active Power Factor Correction, 90% Efficient, with no 6-pin graphics power cables. The Z4 G4 465W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-465AB- 3%20A_465W_ECOS%204939_Report.pdf
	xw	MID_RANGE 750 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2x 6-pin graphics power cables. The Z4 G4 750W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-750AB- 36%20A_750W_ECOS%204938_Report.pdf
		HIGH-END
	XW, CX (i9)	1000 watts wide-ranging, active Power Factor Correction, 90% Efficient. Includes 4x 6+2-pin graphics power cables: also includes a Front Fan and Card Guide kit to enable support for dual high end graphics solutions.
	CX (i7)	1000 watts wide-ranging, active Power Factor Correction, 90% Efficient. Includes 2x 6+2-pin graphics power cables.
		The Z4 G4 1000W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP_D15- 1K0P1A_1000W_ECOS%204838_Report.pdf

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

Supported Components

NOTE: 1000 W internal power supply, up to 90% efficiency, active PFC available the first half of 2018

Workstation ISV	See the latest list of certifications at
Certifications	http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html

Processors		Factory Configure d	Option Kit	Option Kit Part Number	Support Notes
	Intel [®] Xeon [®] W-2100 Series CPU				
	Intel® Xeon® W-2195 2.3 2666 18C CPU	Y	Ν		
	Intel® Xeon® W-2175 2.5 2666 14C CPU	Y	Ν		
	Intel® Xeon® W-2155 3.3 2666 10C CPU	Y	Ν		
	Intel® Xeon® W-2145 3.7 2666 8C CPU	Y	Ν		
	Intel® Xeon® W-2135 3.7 2666 6C CPU	Y	Ν		
	Intel® Xeon® W-2133 3.6 2666 6C CPU	Y	Ν		
	Intel® Xeon® W-2125 4.0 2666 4C CPU	Y	Ν		
	Intel® Xeon® W-2123 3.6 2666 4C CPU	Y	Ν		
	Intel® Xeon® W-2104 3.2 2400 4C CPU	Y	Ν		
	Intel [®] Xeon [®] W-2102 2.9 2400 4C CPU	Y	Ν		
	Intel® Core™ X-Series CPU				
	Intel® Core™ i9-9980XE 3.0 2666 18C CPU	Y	Ν		
	Intel® Core™ i9-9920X 3.5 2666 12C CPU	Y	Ν		
	Intel® Core™ i9-9820X 3.3 2666 10C CPU	Y	Ν		
	Intel® Core™ i7-9800X 3.8 2666 8C CPU	Y	Ν		
	Intel® Core™ i9-7980XE 2.6 2666 18C CPU	Y	Ν		
	Intel® Core™ i9-7960X 2.8 2666 16C CPU	Y	Ν		
	Intel® Core™ i9-7940X 3.1 2666 14C CPU	Y	Ν		
	Intel® Core™ i9-7920X 2.9 2666 12C CPU	Y	Ν		
	Intel® Core™ i9-7900X 3.3 2666 10C CPU	Y	Ν		
	Intel® Core™ i7-7820X 3.6 2666 8C CPU	Y	Ν		
	Intel® Core™ i7-7800X 3.5 2400 6C CPU	Y	Ν		

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Monitors / Displays		Processor Supports	Factory Configure d	Option Kit	Option Kit Part Number	Support Notes
	HP Z Display Z22n G2	XW, CX		Y	1JS05AA	
	HP Z Display Z23n G2	XW, CX		Y	1JS06AA	

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

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Supported Components

HP Z Display Z24i G2	XW, CX	Y	1JS08AA
HP Z Display Z24n G2	XW, CX	Y	1JS09AA
HP Z Display Z24nf G2	XW, CX	Y	1JS07AA
HP Z Display Z27n G2	XW, CX	Y	1JS10AA
HP Z Display Z27s (4K display)	XW, CX	Y	J3G07AA
Supported by all operating systems a Screen size measured diagonally	available from HP		

Storage / Hard Drives*

SAS Hard Drives	SAS Hard Drives for HP Workstations	Processor Supports	Factory Configure d	Option Kit	Option Kit Part Number	Support Notes
	HP 300GB 15k SAS SFF	XW	Y	Y	L5B74AA	
	NOTE: Only available on Xeon W configs SAS	5 controller ac	ld-in card red	quired		

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity may be less. Up to 32GB (for Windows 10) is reserved for system recovery software.

SATA Hard Drives		Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations					
	500GB SATA 7200RPM 6Gb/s 3.5" HDD	XW, CX	Y	Y	LQ036AA	
	500GB SATA 7200RPM 6Gb/s 0PAL2 SFF 3.5" HDD	XW, CX	Y	Y	D8N29AA	
	1TB SATA 7200RPM 3.5" HDD	XW, CX	Y	Y	LQ037AA	
	1TB SATA 7200RPM Ent 3.5" HDD	XW, CX	Y	Y	WOR10AA	
	2TB SATA 7200RPM 3.5" HDD	XW, CX	Y	Y	QB576AA	
	4TB SATA 7200RPM Ent 3.5" HDD	XW, CX	Y	Y	K4T76AA	
	6TB SATA 7200RPM Ent 3.3" HDD	XW, CX	Y	Y	3DH90AA	
	NOTES:Up to (4) 3.5-inch 7200 rpm SATA drive	es: 500 GB, 1.	0, 2.0, 4.0, 16	TB max to	otal	

SATA Solid State Drives		Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Solid State Drives (SSDs) for Workstations					
	HP 256GB SATA SSD	XW, CX	Y	Y	A3D26AA/AT	
	HP 512GB SATA SSD	XW, CX	Y	Y	D8F30AA	
	HP 1TB SATA SSD	XW, CX	Y	Y	F3C96AA/AT	
	HP 2TB SATA SSD	XW, CX	Y	Y	Y6P08AA/AT	
	HP 256GB SATA SED OPAL2 SSD	XW, CX	Y	Y	G7U67AA	

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only



Supported Components

HP 512GB SATA SED OPAL2 SSD	XW, CX	Y	Y	N8T26AA
HP 240GB SATA Enterprise SSD	XW, CX	Y	Y	T3U07AA
HP 480GB SATA Enterprise SSD	XW, CX	Y	Y	T3U08AA

Supported Components

PCIe Solid State Drives

τe					Uption	
		Processor Supports	Factory Configured	Option Kit	Kit Part Number	Support Notes
	PCIe SSDs for HP Workstations					
	HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	1PD56AA	
	HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	1PD57AA/AT	
	HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	1PD58AA	
	HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	1PD59AA/AT	
	HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	1PD60AA	
	HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	1PD61AA	
	HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	ЗКРЗ9АА	
	HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit	XW, CX	Y	Y	4YZ41AA	
	HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit	XW, CX	Y	Y	4YZ44AA/AT	
	HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit	XW, CX	Y	Y	TBD	
	HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Module	XW, CX	Y	Y	TBD	
	HP Z Turbo Drive Quad Pro					
	HP Z Turbo Drive Quad Pro 2x256GB TLC PCIe [®] SSD	XW, CX (i9)	Y	Y	4YZ38AA	1, 4
	HP Z Turbo Drive Quad Pro 2x512GB TLC PCIe® SSD	XW, CX (i9)	Y	Y	4YZ39AA/AT	1,4
	HP Z Turbo Drive Quad Pro 2x1TB TLC PCIe [®] SSD	XW, CX (i9)	Y	Y	4YZ40AA	1,4
	HP Z Turbo Drive Quad Pro 2x2TB PCIe® SSD	XW, CX (i9	Y	Y	3KP42AA	
	HP Z Turbo Drive Quad Pro 256GB TLC SSD module	XW, CX (i9)	Ν	Y	4YZ35AA	1, 3, 4
	HP Z Turbo Drive Quad Pro 512GB TLC SSD module	XW, CX (i9)	Ν	Y	4YZ36AA/AT	1, 3, 4
	HP Z Turbo Drive Quad Pro 1TB TLC SSD module	XW, CX (i9)	Ν	Y	4YZ37AA	1, 3, 4
	HP Z Turbo Drive Quad Pro 2TB TLC SSD module	XW, CX (i9	Ν	Y	3KP43AA	
	HP Z Turbo Drive Dual Pro					
	HP Z Turbo Drive Dual Pro 256GB TLC SSD		Y	Y	4YF60AA	
	HP Z Turbo Drive Dual Pro 512GB TLC SSD		Y	Y	4YF61AA	
	HP Z Turbo Drive Dual Pro 1TB TLC SSD		Y	Y	4YF62AA	
	HP Z Turbo Drive Dual Pro 2TB TLC SSD		Y	Y	4YF63AA	
	Intel® 905p Series SSD (Opatane SSD)					
	Intel® Optane SSD 905p 280GB AiC**		Y	Y	2SC47AA	
	Intel® Optane SSD 905p 480GB AiC**		Y	Y	2SC48AA	
	Intel® Optane SSD 905P 380GB M.2 PCIe Dual		Y	Y	6LA63AA	1
	Intel [®] Optane SSD 905P 2x380GB M.2 PCIe Quad		Y	Y	6LA65AA	1
	Intel [®] Optane SSD 905P 380GB M.2 SSD Module		Y	Y	6LA66AA	3,4

Note 1: All HP Z Turbo Drive Quad Pro modules require the Z4 G4 Fan & Front Card Kit, available as CTO (1MY89AV) and AMO (1XM33AA)

Note 3: M.2 SSD module only, designed to be installed into the Z Turbo Drive Quad Pro or Dual Pro carrier **Note 4:** Z Turbo Drive Quad Pro is not supported on Core i7-X configurations

** PCIe card installed in standard PCIe x4 slot

Option

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only



Supported Components

Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
	Ν	Y	3FJ80AA	1,3	
	Ν	Y	3FJ81AA	2,3	
		Supports Configured	Supports Configured Kit N Y	Processor Factory Option Kit Part Supports Configured Kit Number N Y 3FJ80AA	ProcessorFactoryOptionKit PartSupportSupportsConfiguredKitNumberNotesNY3FJ80AA1,3

NOTE 1: Enables RAID 0, 1 & 10 **NOTE 2:** Enables RAID 0, 1 & 10 plus RAID 5 with write hole closure options. **NOTE 3:** Xeon processor required

Hard Drive Controllers		Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SAS Controller MicroSemi SmartHBA2100-4i4e SAS Controller NOTE: Only available on Xeon W configurations	XW	Y	Y	1FV90AA	

Graphics

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported # of cards
Graphics Cable Adapters						
HP DisplayPort to HDMI Adapter	XW, CX	Y	Y	K2K92AA		
HP DisplayPort to Dual Link DVI Adapter	XW, CX	Y	Y	NR078AA		
HP DisplayPort to DVI-D Adapter	XW, CX	Y	Y	FH973AA		
HP DisplayPort to DVI-D Adapter (2-pack)	XW, CX	Y	Ν			
HP DisplayPort to DVI-D Adapter (4-pack)	XW, CX	Y	Ν			
HP DisplayPort to DVI-D Adapter (6-pack)	XW, CX	Y	Ν			
HP miniDP-to-DP Adapter	XW, CX	Y	Y	2MY05AA		
HP miniDP-to-DP Adapter (2-pack)	XW, CX	Y	Ν			
HP miniDP-to-DP Adapter (4-pack)	XW, CX	Y	Ν			
HP miniDP-to-DP Adapter (8-pack)	XW, CX	Y	Ν			
Graphics Card Connectors						
NVIDIA [®] SLI 2-slot Graphics Connector	XW, CX	Y	Y	2YY84AA		
Quadro® RTX NVLink 2-slot Bridge (RTX 5000)	XW, CX	Ν	Y	6FY12AA		
Quadro® RTX NVLink High-Bandwidth 2-slot Bridge (RTX 6000 & 8000)	XW, CX	Ν	Y	6FY11AA		
Entry 3D						
NVIDIA [®] Quadro [®] P400 2GB Graphics	XW, CX	Y	Y	1ME43AA	4	2
NVIDIA [®] Quadro [®] P620 2GB Graphics	XW, CX	Y	Y	3ME25AA	4	2
Mid-range 3D						
NVIDIA [®] Quadro [®] P1000 4GB Graphics	XW, CX	Y	Y	1ME01AA	3, 4	2

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only



Supported Components

NVIDIA [®] Quadro [®] P2000 5GB Graphics	XW, CX	Y	Y	1ME41AA	3, 4	2
NVIDIA [®] Quadro [®] P2200 5GB Graphics	XW, CX	Y	Y	6YT67AA	3, 4	2
AMD Radeon™ Pro WX 3100 4GB Graphics	XW, CX	Y	Y	2TF08AA	3, 4	2
AMD Radeon™ Pro WX 3200 4GB Graphics	XW, CX	Y	Y	6YT68AA	3, 4	2
AMD Radeon™ Pro WX 4100 4GB Graphics	XW, CX	Ν	Y	Z0B15AA	3, 4	2
High-End 3D						
NVIDIA [®] Quadro [®] P4000 8GB Graphics	XW, CX	Y	Y	1ME40AA	1, 2, 5	2
NVIDIA [®] Quadro [®] RTX 4000 8GB Graphics	XW, CX	Y	Y	5JV89AA	1, 2	2
AMD Radeon™ Pro WX 7100 8GB Graphics	XW, CX	Y	Y	ZOB14AA	1, 2	2
Ultra High-End 3D						
NVIDIA [®] Quadro [®] GP100 16GB Graphics	XW, CX	Y		1ZE81AA	1, 2, 5	2
NVIDIA [®] Quadro [®] GV100 32GB Graphics	XW, CX	Y		3ME26AA	1, 2, 5	2
NVIDIA [®] Quadro [®] P5000 16GB Graphics	XW, CX	Y	Y	ZOB13AA	1, 2, 5	2
NVIDIA [®] Quadro [®] P6000 24GB Graphics	XW, CX	Y	Y	Z0B12AA	1, 2, 5	2
NVIDIA [®] Quadro [®] RTX 5000 16GB Graphics	XW, CX	Y	Y	5JH81AA	1, 2	2
NVIDIA [®] Quadro [®] RTX6000 24GB Graphics	XW, CX	Y	Y	5JH80AA	1, 2	2
NVIDIA [®] Quadro [®] RTX 8000 48 GB Graphics	XW, CX	Y	Y	6NB51AA	1, 2	2
AMD Radeon™ Pro WX 9100 16GB Graphics	XW, CX	Y		2TF01AA	1, 2	1
NVIDIA [®] Quadro [®] Sync II	XW, CX	Y	Y	1WT20AA		

NOTE 1: Single graphics configuration requires the HP Z4 G4 Fan and Front Card Guide Kit, which is available both CTO (1MY89AV) and AMO (1XM33AA).

NOTE 2: Single graphics configuration requires the 750W chassis or 1000W chassis.

NOTE 3: Dual graphics configuration requires the HP Z4 G4 Fan and Front Card Guide Kit, which is available both CTO (1MY89AV) and AMO (1XM33AA).

NOTE 4: Dual graphics configuration requires the 750W chassis or 1000W chassis.

NOTE 5: Dual graphics configuration requires the 1000W chassis.

Memory	СТО	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	DDR4-2666 ECC Registered DIMMs					
	HP 8GB (1x8GB) DDR4-2666 ECC Reg RAM	XW	Y	Y	1XD84AA/AT	1
	HP 16GB (2x8GB) DDR4-2666 ECC Reg RAM	XW	Y			1
	HP 24GB (3x8GB) DDR4-2666 ECC Reg RAM	XW	Y			1
	32GB (4x8GB) DDR4-2666 ECC Reg RAM	XW	Y			1
	64GB (8x8GB) DDR4-2666 ECC Reg RAM	XW	Y			1
	16GB (1x16GB) DDR4-2666 ECC Reg RAM	XW	Y	Y	1XD85AA/AT	1
	32GB (2x16GB) DDR4-2666 ECC Reg RAM	XW	Y			1
	64GB (4x16GB) DDR4-2666 ECC Reg RAM	XW	Y			1
	128GB (8x16GB) DDR4-2666 ECC Reg RAM	XW	Y			1
	32GB (1x32GB) DDR4-2666 ECC Reg RAM	XW	Ν	Y	1XD86AA/AT	1, 2
	64GB (2x32GB) DDR4-2666 ECC Reg RAM	XW	Y			1, 2
	128GB (4x32GB) DDR4-2666 ECC Reg RAM	XW	Y			1, 2
	256GB (8x32GB) DDR4-2666 ECC Reg RAM	XW	Y			1, 2

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only



Supported Components

HP 8GB (1x8GB) DDR4-2666 nECC RAM	СХ	Y	Y	3PL81AA	1
HP 16GB (2x8GB) DDR4-2666 nECC RAM	СХ	Y			1
HP 32GB (4x8GB) DDR4-2666 nECC RAM	СХ	Y			1
HP 64GB (8x8GB) DDR4-2666 nECC RAM	СХ	Y			1
HP 16GB (1x16GB) DDR4-2666 nECC RAM	СХ	Y	Y	3PL82AA	1
HP 32GB (2x16GB) DDR4-2666 nECC RAM	СХ	Y			1
HP 64GB (4x16GB) DDR4-2666 nECC RAM	СХ	Y			1
HP 128GB (8x16GB) DDR4-2666 nECC RAM	СХ	Y			1

NOTES:

For details on the supported memory configurations on the HP Z4 G4 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 4 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If an 2400MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2400MT/s, regardless of the specified speed of the memory.

NOTE 1: ONLY DDR4 DIMMs are supported.

NOTE 2 Memory configurations using 32GB DIMMs require the HP Z4 Memory Cooling Solution, which is available both CTO (1MY90AV) and AMO (1XM34AA).

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxAT) HP memory part numbers designated as "2666" will be transitioned to use "2933" speed memory components. This does not affect HP part number availability nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" have been tested to work with "2933" memory and are fully-supported by HP under standard support terms.

Multimedia and Audio Devices

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Supported Components

Multimedia and Audio Devices

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
Integrated Realtek HD ALC221 Audio	XW, CX	Y	Ν			

Optical and Removable Storage

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives					
HP 9.5mm Slim Blu Ray Disc Writer	XW, CX	Y	Y	K3R65AA	1
HP 9.5mm Slim DVD ROM	XW, CX	Y	Y	K3R63AA	1
HP 9.5mm Slim DVD Writer*	XW, CX	Y	Y	K3R64AA	1
HP HH DVD Writer (16x RW DVD-R)	XW, CX	Y	Y	4AR67AA	
HP SD Card Reader					
HP SD 4 Card Reader	XW, CX	Y	Y	2VK54AA	
NVMe Frame/Carrier					
HP QX310 Removable NVMe Frame/Carrier w/PCIe card	XW, CX	Ν	Y	8GQ89AA/AT	

NOTE 1: Installing an optical drive into Z4 G4 requires a 5.25" external bay adapter (Option Kit Part number NQ099A).

*Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Networking and Communications

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel® i350-T2 PCIe Dual Port Gigabit NIC	XW, CX	Y	Y	V4A91AA	
Intel® i350-T4 PCIe 4-Port Gigabit NIC	XW, CX	Ν	Y	W8X25AA	
Intel [®] Ethernet I210-T1 PCIe x1 Gb NIC	XW, CX	Y	Y	E0X95AA	
Aquantia [®] AQN-108 Single-Port 5GbE NIC	XW, CX	Ν	Y	1PM63AA	
Intel [®] X550-T2 10GbE Dual Port NIC	XW, CX	Y	Y	1QL46AA	
Intel [®] X710-DA2 10GbE SFP+ Dual Port NIC	XW, CX	Y	Y	1QL47AA	1
HP 10GbE SFP+ SR Transceiver	XW, CX	Y	Y	C3N53AA	
Intel 8265 802.11 a/b/g/n/ac + BT PCIe WLAN	XW, CX	Ν	Y	1QL48AA	

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019



QuickSpe			н	P Z4 G4 Workstation	
Supported Compo	nents				
	Intel® Wi-Fi 6 AX200 & BT PCIe Note 1: Windows 7 is NOT supported	XW, CX	Ν	Y	7CE01AA

Racking and Physical Security

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Supported Components

Racking and Physical Security

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
HP Z4/Z6 Side Panel Barrel Keylock	XW, CX	Y	Ν			
HP Solenoid Lock / Hood Sensor	XW, CX	Y	Ν			
HP Z4/Z6 Depth Adjustable Fixed Rail Rack Kit	XW, CX	Ν	Y	2HW42AA		
HP Keyed Cable Lock 10mm	XW, CX	Ν	Y	T1A62AA		

Input Devices

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Wireless Business Slim Keyboard and Mouse	XW, CX	Y	Y	N3R88AA	
Business Slim PS/2 Wired Keyboard	XW, CX	Y	Y	N3R86AA	
USB Business Slim Wired Keyboard	XW, CX	Y	Y	N3R87AA	
USB Premium Wired Keyboard	XW, CX	Y	Y	Z9N40AA/AT	
USB Wired SmartCard CCID Keyboard	XW, CX	Y	Y	E6D77AA	
3Dconnexion CADMouse	XW, CX	Y	Y	M5C35AA	
HP Optical USB Mouse	XW, CX	Y	Y	QY777AA/AT	
HP PS/2 Mouse	XW, CX	Y	Y	QY775AA/AT	
HP USB Hardened Mouse	XW, CX	Y	Y	P1N77AA/AT	

Other Hardware

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP ENERGY STAR [®] Certified Configuration	XW, CX	Y			
HP Z Premium Front I/O 2xUSB-A 2xUSB-C	XW, CX	Y	Y	1XM32AA	
HP Thunderbolt 3 PCIe 2 Port I/O Card	XW, CX	Y	Y	3UU05AA	
HP Z4 G4 Memory Cooling Solution	XW, CX	Y	Y	1XM34AA	Note 1
HP Z4 G4 Fan and Front Card Guide Kit	XW, CX	Y	Y	1XM33AA	Note 2
HP Internal USB Port Kit	XW, CX	Ν	Y	EM165AA	Note 3
HP eSATA 2 port PCIe Bulkhead Kit	XW, CX	Y	Y	GM110AA	
HP Serial Port Adapter	XW, CX	Y	Y	PA716A	
HP Workstation Mouse Pad	XW, CX	Y			

Note 1: The HP Z4 G4 Memory Cooling Solution is available to add to any configuration for improved system cooling, but is required for memory configurations using 32GB DIMMs.

Note 2: Fan and Front Card Guide required with the following components: - Specific graphics configurations (see Graphics section above)

- Any HP Z Turbo Quad Pro configuration

Note 3: The HP Internal USB Port kit has a single USB 2.0 type A connector.

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only



Supported Components

Software		Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Sobey Video Editing SW	XW, CX	Y	Ν		China only
	SW HP RGS for Z	XW, CX	Y	Ν		
	HP Sure Start Gen3	XW, CX	Y	Ν		1
	Note 1: Available on products	equipped with Int	tel® 7th gener	ation proc	essors.	

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019 Page 18

HP Z4 G4 Workstation

Supported Components

Operating Systems		Processor Supports	Support Notes
	Windows 10 Pro 64 for Workstations	XW	Note 1
	Windows 10 Pro 64	CX (i7)	Note 2
	Windows 10 Pro High End	CX (i9)	
	Windows 7 Professional 64-bit	XW	Note 3
	Windows 10 Downgrade to Windows 7*	XW	
	HP Linux [®] Ready	XW, CX	Note 4
	Red Hat [®] Enterprise Linux [®] (RHEL) Workstation - Paper License (1yr)	XW, CX	Note 5
	*only available in China through June 2019.		

NOTE 1: Only applicable to Xeon W configurations

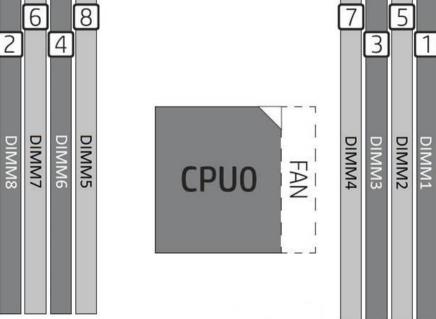
NOTE 2: Only applicable to Core i7 X configurations **NOTE 3**: Not supported or available for Core X configurations. For detailed Windows 7 OS hardware support information see http://h10032.www1.hp.com/ctg/Manual/c05857891.pdf.

NOTE 4: includes drivers for 64-bit OS versions of RHEL 6 & 7, SUSE Linux[®] Enterprise Desktop 11 and Ubuntu 14.04. For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

NOTE 5: This second OS must be ordered with the HP Linux[®] Installer Kit as the first OS.

System Technical Specifications

System Board		
System Board Form	Main Syst	tem Board:
Factor	27.7 x	28.0 cm
	10.9 x 1	1.0 inches
Processor Socket	Single LG	A2066 R4
Chipset	Intel [®] Xeon [®] W Processor Family	Intel® Core™ X-series Processors
• • • • • • • • • • • • • • • • • • • •	Intel [®] C422 Chipset	Intel [®] X299 chipset
Super I/O Controller	•	I 5HAODX (SIO-15)
Memory Expansion		emory slots
Slots		
Memory Type	DDR4, RDIMM (Registered), ECC: 8GB, 16GB and	DDR4, UDIMM, non-ECC: 8GB and 16GB
Supported	32GB	
Memory Modes	Channel I	nterleaved
Memory Speed	2666MT/s, 2400M	IT/s, and 2133MT/s
Supported		
Memory Protection	ECC available on data, parity on address and command	N/A
Maximum Memory	Supports up to 256GB	Supports up to 128GB
Memory Configuration (Supported)	Only Registered DIMMs are supported.	Only non-ECC unbuffered DIMMs are supported
Memory Load Order		
	ត ខា	



Note on Maximum Memory Maximum memory capacities assume 64-bit operating systems such as Windows 10 Pro 64-bit, Windows 7 Professional 64-bit.

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

System Technical Specifications

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible system memory is 192GB

PCI Express Connectors	Intel® Xeon® W Processor Family	Intel® Core™ X-series Processors
	Slot 1 (top): PCI Express	Gen3 x16 supplied by CPU.
	Slot 2 (PCH): PCI Express Gen3 x4 suppli	ied by PCH with open-ended connector. **
	Slot 3:	Slot 3:
	PCI Express Gen3 x16 supplied by CPU	Core i9-X and Core i7-9800X configs: PCI Express Gen3 x16 supplied by CPU
		Core i7-X configs: PCI Express Gen3 x16 (mechanical)/ x8 (electrical)supplied by CPU
	Slot 4 (PCH): PCI Express Gen3 x4 suppl	lied by PCH with open-ended connector**
	Slot 5:	Slot 5:
	PCI Express Gen3 x8 supplied by CPU with open- ended connector**	 Core i9-X and Core i7-9800X configs: PCI Express Gen3 x8 supplied by CPU with open- ended connector** Other Core i7-X configs: PCI Express Gen3 x8
		(mechanical-only, no data) with open-ended connector**
	NOTE: Slots 1 through 5 support full-	neight, full-length cards (with extender)
	M.2 Slot 1: PCI Express	Gen3 x4 supplied by CPU
	Socket Type 3, Key M, H4.2, sizes 2	260-D5-M, 2280-D5-M, 22110-D5-M
	M.2 Slot 2:	M.2 Slot 2:
	PCI Express Gen3 x4 supplied by CPU Socket Type 3, Key M, H4.2, sizes 2260-D5-M, 2280-D5-M, 22110-D5-M	No 2nd M.2 connector/slot available
		vidth (e.g. x16) card to be installed physically into a h connector/slot.

System Technical Specifications

Supported Drive Interfaces			
SATA		ipports RAID 0,1, 5, and 10	
		ATA RAID is Microsoft Windows only	
Serial Attached SCSI	Intel [®] Xeon [®] W Processor Family Requires Optional PCIe card	Intel [®] Core™ X-series Processors not supported	
Factory Configured RAII	· ·	0 striped array	
	• RAID 1	mirrored array	
		ed and mirrored array «®. Use SW RAID functionality provided in the Red Hat	- ®
		g system instead.	
Integrated Graphics		No	
Network Controller	Intel [®] Xeon [®] W Processor Family	Intel® Core™ X-series Processors	
	Intel [®] I219-LM PCIe GbE LAN	Intel [®] I219-V PCIe GbE LAN	
	Intel® I210-AT PCIe GbE LAN Supports the following management functionalitie	Supports the following management functionalities: WOL and PXE 2.1	ties:
	Intel AMT11.1x, TXT, DASH 1.1, WOL, VLAN, Teaming and PXE 2.1		
External SATA (eSATA)		figurable with optional eSATA* cable kit	
	* hot plug / hot swap	p not supported with eSATA	
IDE connector		Νο	
Floppy connector		Νο	
Serial	1 inte	ernal header	
2nd Serial		No	
Parallel		No	
AUX IN (audio)		No	
IEEE 1394 Connector(s) Front		None	
riviit		None	
Rear		None	
Internal		None	
USB Connector(s)			
Front		which FIO module is selected:	
		3.1 G1 Type A (1 charging) e C™, 2 USB 3.1 G1 Type A (1 charging)	
Rear	Intel® Xeon® W Processor Family	Intel [®] Core™ X-series Processors	
Internal	6 USB 3.1 G1 Type A	5 USB 3.1 G1 Type-A	
Internal		I single-port header single-port header	
) dual-port header	

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only

System Technical Specifications

Power Supply Headers Power Switch, Power LED &	TPM Certified products list https://trustedcomputinge Yes Yes								
Hard Drive LED Header	res								
Clear Password Jumper	Yes								
Serial Port	1 internal header								
Parallel Port	No								
Keyboard/Mouse	USB or PS/2								
Hood Lock Header	Yes								
Hood Sensor Header	Yes								
Memory Fan	1 Memory Fan Header								
AUX IN (audio) Power Supply	No								
rowei supply	750W 90% Efficie	nt Custom PSU	465W 90% Effici	ent Custom PSII					
Power Supply	(Wide-Ranging		465W 90% Efficient, Custom PSU (Wide-Ranging, Active PFC)						
Operating Voltage Range	90–269		90–269 VAC						
Rated Voltage Range	100-240 VAC	118 VAC	100-240 VAC	118 VAC					
Rated Line Frequency	50–60 Hz	400 Hz	50–60 Hz	400 Hz					
Operating Line Frequency									
Range	47–66 Hz	393–407 Hz	47–66 Hz	393–407 Hz					
Rated Input Current	100-240V @ 10A	118V @ 10A	100-240V @ 6A	118V @ 6A					
Heat Dissipation (Configuration and software dependent)	Typical = 18 Max = 3084		Typical = 1 Max = 19	147 btu/hr 12 btu/hr					
Power Supply Fan	80x25 mm var	riable speed	80x25 mm va	ariable speed					
ENERGY STAR [®] Certified	Yes	5	Ye	25					
(Configuration dependent)	90% Eff	icient	90% E1	fficient					
(Configuration dependent)									
(Configuration dependent)		upply officiency report	The 74 C4 46EW power	The Z4 G4 750W power supply efficiency report The Z4 G4 465W power supply efficiency report					
	The Z4 G4 750W power s								
(Configuration dependent) 80 PLUS® Compliant	The Z4 G4 750W power so can be found	at this link:	can be found	d at this link:					
	The Z4 G4 750W power so can be found https://plugloadsolutions.	at this link: .com/psu_reports/HP%	can be found https://plugloadsolution	d at this link: s.com/psu_reports/HP%					
	The Z4 G4 750W power so can be found	at this link: .com/psu_reports/HP% -750AB-	can be found https://plugloadsolution 20INC_DP	d at this link:					

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

System Technical Specifications

Power Supply	1000W 90% Efficie						
	(Wide-Ranging	, Active PFC)					
Operating Voltage Range	90–269	90–269 VAC					
Rated Voltage Range	100-127 VAC 200-240 VAC	118 VAC					
Rated Line Frequency	50–60 Hz	400 Hz					
Operating Line Frequency Range	47–66 Hz	393–407 Hz					
Rated Input Current	12A @100-127 VAC 6.3A @ 200-240 VAC	12A @ 118VAC					
Heat Dissipation (Configuration and software dependent)	Typical = 24 Max = 411						
Power Supply Fan	80x25 mm va	riable speed					
ENERGY STAR® Certified (Configuration dependent)	Yes						
	90% Eff	icient					
80 PLUS [®] Compliant	The Z4 G4 1000W power supply efficie	ency report can be found at this link:					
	https://plugloadsolutions.com/psu_reports/HP_D	15-1K0P1A_1000W_EC0S%204838_Report.pdf					
FEMP Standby Power Compliant @115V <1W in S5 – Power Off)	Yes	Yes					
EuP Compliant @ 230V (<0.5 W in S5 – Power Off)	Yes	Yes					
CECP Compliant @ 220V (<4W in S3 – Suspend to RAM)	Yes; Configuration dependent	Yes; Configuration dependent					
Power Consumption in sleep mode							
(as defined by ENERGY STAR®) – Suspend to RAM (S3)	TBD	TBD					
(1997) (Instantly Available PC)							
Built-in Self Test LED	Yes	Yes					
Surge Tolerant Full Ranging							
Power Supply (withstands power surges up to 2000V)	Yes	Yes					

NOTE: 1000 W internal power supply, up to 90% efficiency, active PFC available the first half of 2018

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019 Page 24



System Technical Specifications

System Configuration

Example Z4 G4	Processor	1x Intel Xeon	W-2102 4C 2.9	GHz				
Workstation	Memory	1x 8GB DDR4-	1x 8GB DDR4-2666 (Registered DIMM)					
Configuration #1	Graphics	1x NVIDIA Qua	adro P400					
ENERGY STAR®	Disks / Optical	1x 500GB SAT	1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA					
Certified	Power Supply	465W 90% cu	stom PSU					
	Other	N/A						
		115 VAC 230 VAC 100 V						
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (SO)		42	.323	41.	338	42.585		
	Windows Busy Typ(SO)	Т	TBD		TBD		3D	
	Windows Busy Max (SO)	90	.231	92.323		90.786		
	Sleep (S3)	3.449	3.440	3.566	3.558	3.530	3.410	
	Off (S5)	1.041	1.014	1.242	1.231	1.310	1.180	
	Zero Power Mode (ErP)	0.	187	0.43		0.174		
		115	5 VAC	230 VAC		100 VAC		
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (SO)	144	1.406	141	.045	145	.301	
	Windows Busy Typ(SO)	Т	BD	TI	BD	TBD		
	Windows Busy Max (SO)	307.868		315	.006	309	.761	
	Sleep (S3)	11.767	11.737	12.167	12.140	12.044	11.634	
	Off (S5)	3.551	3.459	4.237	4.200	4.469	4.026	
	Zero Power Mode (ErP)	0.	638	1.4	467	0.5	594	

Example Z4 G4	Processor	1x Intel Xeon W-2123 4C 3.6GHz						
Workstation	Memory	2x 8GB DDR4-2666 (Registered DIMM)						
Configuration #2	Graphics	1x NVIDIA QuadroP1000						
ENERGY STAR®	Disks / Optical	1x 500GB SA1	ΓΑ 7200 ; 1x Sliı	m DVD-ROM S	ATA			
Certified	Power Supply	750W 90% custom PSU						
	Other	N/A						
Energy Consumption		11!	5 VAC	230	230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (SO)	39	.947	39.569		40.956		
	Windows Busy Typ(SO)	1	BD	TBD		TBD		
	Windows Busy Max (SO)	149	9.543	150.789		147.845		
	Sleep (S3)	3.615	3.566	3.801	3.798	3.634	3.621	
	Off (S5)	1.079	1.016	1.440	1.238	1.320	1.170	
	Zero Power Mode (ErP)	0.	204	0.430		0.191		
		11	5 VAC	230	VAC	100	VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

System Technical Specifications

(Btu/hr)	Windows Idle (SO)	136.299 TBD 510.241		135.009 TBD 514.492		139.741 TBD 504.447	
1	Windows Busy Typ(SO)						
	Windows Busy Max (S0)						
	Sleep (S3)	12.338	12.167	12.969	12.959	12.399	12.355
	Off (S5)	3.681	3.466	4.913	4.224	4.504	3.992
	Zero Power Mode (ErP)	0.696		1.467		0.651	

Example Z4 G4	Processor	1x Intel Xeon	W-2133 6C 3.6	GHz				
Workstation	Memory	4x 8GB DDR4	-2666 (Register	red DIMM)				
Configuration #3	Graphics	1x NVIDIA QuadroP2000						
	Disks/Optical	2x 1TB SATA7200 ; 1x Slim SuperMulti DVDRW SATA						
	Power Supply	750W 90% cu	istom PSU					
	Other	N/A						
Energy Consumption		115	5 VAC	230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
·	Windows Idle (SO)	48.759		46.	46.321		46.578	
·	Windows Busy Typ(SO)	TBD		199.56		206.055		
	Windows Busy Max (SO)	209.60		208.66		198.82		
·	Sleep (S3)	4.360	4.351	4.538	4.508	4.299	4.277	
	Off (S5)	1.039	1.017	1.42	1.219	1.015	0.997	
· 	Zero Power Mode (ErP)	0.203		0.399		0.191		
		115	5 VAC	230	VAC	100 VAC		
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (SO)	160	5.366	258.047		158.924		
	Windows Busy Typ(SO)	Т	BD	TBD		TE	3D	
	Windows Busy Max (SO)	71	5.155	711	.947	678	.373	
1	Sleep (S3)	14.876	14.845	15.483	15.381	14.668	14.593	
1	Off (S5)	3.544	3.470	4.845	4.179	3.463	3.402	
1	Zero Power Mode (ErP)	0.	692	1.3	861	0.6	551	

Example Z4 G4	Processor	ory 8x 32GB DDR4-2666 (Registered DIMM)						
Workstation	Memory							
Configuration #4	Graphics							
1	Disks / Optical	4x 2TB SATA 7200 ; 0x ODD						
	Power Supply							
	Other							
Energy Consumption		115	VAC	230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
1	Windows Idle (SO)	65.9	959	69.321		68.635		
	Windows Busy Typ(SO)	TE	BD	TBD		TBD		
1	Windows Busy Max (SO)	463	.23	456.95		503.125		

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

System Technical Specifications

	Sleep (S3)	6.336	6.102	6.971	6.189	6.266	6.264
	Off (S5)	1.047	1.036	1.254	1.222	1.014	0.995
	Zero Power Mode (ErP)	0.2	03	0.3	99	0.1	91
		115	VAC	230	VAC	100	VAC
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (SO)	225.052		236.523		234.183	
	Windows Busy Typ(SO)	TB	D	TE	3D	TE	3D
	Windows Busy Max (SO)	1580	.541	1559	9.113	1716	5.663
	Sleep (S3)	21.618	20.821	23.785	21.117	21.379	21.372
	Off (S5)	3.572	3.534	4.278	4.169	3.459	3.394
	Zero Power Mode (ErP)	0.6	92	1.361		0.652	

Example Z4 G4	Processor	1x Intel Core i	7-7800X 3.50	Hz 6C				
Workstation	Memory	2x 8GB DDR4-	2666 (non-E	CC DIMM)				
Configuration #5	Graphics	1x NVIDIA Quadro P1000						
	Disks / Optical	1x 1TB SATA 7	7200 : 1x Slim	DVD-ROM SA	ГА			
	Power Supply	1000W 90% c	ustom PSU					
	Other	N/A						
Energy Consumption		115	VAC	230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (SO)	46.9	909	47.	175	46.	909	
	Windows Busy Typ(SO)	TBD		TBD		TBD		
	Windows Busy Max (S0)	201.83		199.97		203.41		
	Sleep (S3)	3.041	2.971	3.165	3.041	2.971	3.165	
	Off (S5)	0.978	0.898	1.159	0.978	0.898	1.159	
	Zero Power Mode (ErP)	0.1	99	0.379		0.187		
		115	VAC	230 VAC		100 VAC		
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (SO)	160.	053	160.961		160.053		
	Windows Busy Typ(SO)	TE	3D	T	3D	TE	3D	
	Windows Busy Max (SO)	688.	644	682	.297	694	.035	
	Sleep (S3)	10.376	10.137	10.799	10.376	10.137	10.799	
	Off (S5)	3.337	3.064	3.954	3.337	3.064	3.954	
	Zero Power Mode (ErP)	0.6	78	1.2	.93	0.638		

Example Z4 G4	Processor	1x Intel Core i7-7920X 2.9GHz 12C
Workstation	Memory	4x 16GB DDR4-2666 (non-ECC DIMM)
Configuration #6	Graphics	1x NVIDIA Quadro P4000
	Disks / Optical	2x 2TB SATA 7200 : 1x Slim DVD-ROM SATA
	Power Supply	1000W 90% custom PSU

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

System Technical Specifications

	Other	N/A					
Energy Consumption		115	VAC	230 VAC		100	VAC
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	53.3	392	51.	332	53.	367
	Windows Busy Typ(SO)	TB	D	TE	3D	TE	3D
	Windows Busy Max (SO)	318	.58	307	.82	319).71
	Sleep (S3)	3.558	3.486	3.694	3.558	3.486	3.694
	Off (S5)	0.972	0.895	1.160	0.972	0.895	1.160
1	Zero Power Mode (ErP)	0.201		0.391		0.186	
		115	VAC	230	VAC	100	VAC
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (SO)	182.	174	175	.144	182.088	
	Windows Busy Typ(SO)	TB	D	TE	3D	TBD	
	Windows Busy Max (SO)	1086	.994	1050).281	1090.851	
	Sleep (S3)	12.139	11.894	12.604	12.139	11.894	12.604
	Off (S5)	3.316	3.054	3.957	3.316	3.054	3.957
	Zero Power Mode (ErP)	0.6	85	1.3	34	0.6	34

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

DECLARED NOISE EMISSIONS

Declared Noise Emissions (Entry-level and High-end configurations)					
System Configuration	Processor Info	Intel [®] Xeon [®] W-2125 4.0 2666 4C CPU			
(Entry level)	Memory Info	32GB (4x8GB) DDR4-2666 ECC Reg RAM			
	Graphics Info	1-NVIDIA [®] Quadro [®] P400 2GB			
	Disks/Optical	1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer			
	Power Supply	465 W			

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.2	13
	Hard drive Operating (random reads)	3.4	15

System Configuration (High end)	Processor Info	Intel [®] Xeon [®] W-2155 3.3 2666 10C
	Memory Info	128GB (8x16GB) DDR4-2666 ECC Reg RAM
	Graphics Info	1-NVIDIA [®] Quadro [®] P6000 24GB
	Disks/Optical	2-4TB SATA 7200RPM Ent 3.5" / 1-HP 9.5mm Slim Blu Ray Disc Writer
	Power Supply	750 W

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019



System Technical Specifications

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)	
	Idle	3.5	22	
	Hard drive Operating (random reads)	3.7	23	

System Configuration	Processor Info	Intel [®] Core i9-7900X 3.3 2666 10C			
(Entry Level 2)	Memory Info	32GB (4x8GB) DDR4-2666 nECC RAM			
	Graphics Info	1-NVIDIA [®] Quadro [®] P400 2GB			
	Disks/Optical	1-500GB SATA 7200RPM Ent 3.5" / 1-HP 9.5mm Slim Blu Ray Disc Writer			
	Power Supply	1000 W			

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.4	16
	Hard drive Operating (random reads)	3.5	17

System Configuration (High end 2)	Processor Info	Intel®Core i9-7980XE 2.6 2666 18C
	Memory Info	128GB (8x16GB) DDR4-2666 nECC RAM
	Graphics Info	1-NVIDIA [®] Quadro [®] P6000 24GB
	Disks/Optical	2-4TB SATA 7200RPM Ent 3.5" / 1-HP 9.5mm Slim Blu Ray Disc Writer
	Power Supply	1000 W

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.5	20
	Hard drive Operating (random reads)	3.7	21

NOTE: Higher noise levels may be experienced with non-HP approved graphic card(s). Some consumer graphics cards have side blowing fans that may heat up thermal sensor(s) on the mother board causing fans to ramp.

ENVIRONMENTAL DATA

Environmental Requirements	Temperature	Non-operating: -40° to 60° C (-40° to 140° F) Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Maximum rate of change: 10 °C/hr No direct sustained sunlight
	Humidity	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only



System Technical Specifications

	Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb
Maximum Altitude	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details.
Shock (non-repetitive)	Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) Non-operating square: 422 cm/s, 20g
Vibration	Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Physical Security and Serviceability

Access Panel	Tool-less
Access Panel	Includes system board and memory information.
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Blue User Touch Points	Yes, on primary serviceable components.
Color-coordinated Cables	Yes
and Connectors	
Memory	Tool-less
System Board	Screw-In
Dual Color Power/Failure LED	Yes
HDD Activity LED	Yes
	Note: HDD Activity LED is not dual-color
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes, at POST screen on reboot
Restore CD/DVD Set	Restores the computer to its original factory shipping image; can be obtained via HP Support.
Dual Function Front	Yes, causes a fail-safe power off when held for 4 seconds
Power Switch	
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 7.0 mm (0.2756 in) diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only

System Technical Specifications

Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports		
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)		
Power-On Password	Yes, prevents an unauthorized person from booting	g up the workstation	
Setup Password	Yes, prevents an unauthorized person from changi		
3.3V Aux Power LED on System PCA	Yes		
NIC LEDs (integrated) (Green & Amber)	Yes		
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less		
Power Supply Diagnostic LED	Yes		
Front Power Button	Yes, ACPI multi-function		
Rear Power Button	Yes		
Front Power LED	Yes, white (normal), red (fault)		
Front Hard Drive Activity LED			
Front ODD Activity LED	Yes, on device		
Internal Speaker	Yes		
System/Emergency ROM Flash Recovery			
Cooling Solutions	Air cooled forced convection heatsinks		
Power Supply Fans	80 mm x 80 mm x 25 mm (non-serviceable)		
CPU Heatsink Fan	Intel® Xeon® W Processor Family	Intel® Core™ X-series Processors	
	92 mm x 92 mm x 25 mm, 5-wire, PWM	Core i7-X configs: 92 mm x 92 mm x 25 mm, 5- wire, PWM Core i9-X 165W CPU configs: 92 mm x 92 mm x 25 mm, 6-wire, PWM (includes 6-to-5pin cable adapter) NOTE: Core i9X 140W use the same Heatsink as Core i7X and Xeon	
Chassis Fan	Front: (Optional) 92 mm x 92mm x 25 mm, 4-wire, PWM		
	Rear: 120 mm x 120mm x 25 mm, 4-wire, PWM		
Memory Heatsink Fan HP PC Hardware Diagnostics UEFI	Dual 60 mm x 60 mm x 25 mm, 6-wire, PWM, Blindmate (optional based on configuration) HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is available as a download from HP Support.		
Access Panel Key Lock ACPI-Ready Hardware	Yes, side panel barrel keylock (optional from the factory only) Advanced Configuration and Power Management Interface (ACPI).		

• Allows the system to wake from a low-power mode.

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

System Technical Specifications

Controls system power consumption, making it possible to place individual cards and • peripherals in a low-power or powered-off state without affecting other elements of the system

System
Infineon TPM 2.0 Certified
Yes, Front handle and dedicated rear recess
Requires T15 Torx or flat blade screwdriver
Yes, rear (all), middle (all), front (full-length cards with extender, using HP Z4 G4 Fan and Front Card Guide Kit)
Yes

BIOS

BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
АТАРІ	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.
Replicated Setup	Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.8, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	Monitors the temperature state within the chassis. Three modes:
	 NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before bardware component damage accurs.
Remote ROM Flash	without warning before hardware component damage occurs. Provides secure, fail-safe ROM image management from a central network console.
ACPI (Advanced	Allows the system to enter and resume from low power modes (sleep states).
Configuration and Power Management Interface)	Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only 卿

System Technical Specifications

	Supports ACPI 5.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location with Intel Xeon W Processors. For systems with Intel Core X-Series Processors, Wake on LAN is supported, however to remotely restart or shutdown a system, a remote desktop application must be used to manually Restart or Shutdown.
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW applications can use and report this information.
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with local keyboard mappings.
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
Industry Standard	
Specification Support	Devicing Guese acts at hus the DIOC
Industry Standard	Revision Supported by the BIOS
UEFI Specification Revision	2.5
ACPI	Advanced Configuration and Power Management Interface, Version 5.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0
РММ	POST Memory Manager Specification, Version 1.01
SATA	Serial ATA Specification, Revision 1.0a
	Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5
	Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
ТРМ	Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X

System Technical Specifications

	Common Criteria EAL4+ Certified FIPS 140-2 Certified
	TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification
	Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 G1 Specification
	Universal Serial Bus Revision 3.1 G2 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.8

External BIOS simulator found at: http://h20464.www2.hp.com/index.html

Social and Environmental Responsibility

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- ENERGY STAR[®] (energy-saving features available on selected configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- The ECO declaration (TED)

The Z4 G4 is registered EPEAT[®] Gold in the US and Canada. EPEAT[®] registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options The battery in this product complies with EU Directive 2006/66/EC **Batteries** Battery mass: 3q Battery type: Lithium Metal The battery in this product does not contain: Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight • Lead greater than 40ppm by weight **Restricted Material Usage** This product meets the material restrictions specified in HP's General Specification for the Environment. HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis This product is low-halogen except for power cords, external cables and peripherals. Service parts Low Halogen Statement obtained after purchase may not be low-halogen. **End-of-Life Management** HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. and Recycling Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1. 2019



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System Technical Specifications

HP Inc. Corporate	For more information about HP's commitment to the envir	onment:	
Environmental	Sustainability Report		
Information	Eco-label certifications ISO 14001 certificates		
Additional Information	 This HP product is designed to comply with the Wa (WEEE) Directive – 2002/96/EC. Product Disassem 		
	 Plastic parts weighing over 25 grams used in the p ISO1043. 		
Packaging	HP Workstation product packaging meets the HP's General	Specification for the Environment	
	 Does not contain restricted substances listed in H the Environment Does not contain ozone-depleting substances (OE Does not contain heavy metals (lead, mercury, car 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled cor All packaging material is recyclable All packaging material is designed for ease of disa Reduced size and weight of packages to improve in Plastic packaging materials are marked according formatting A multi-unit eco packaging option is available to in packaging material or has a lower volume footpring 	OS) dmium or hexavalent chromium) in excess of ntent materials in packaging materials assembly transportation fuel efficiency g to ISO 11469 and DIN 6120 standards institutional customers that uses less nt than conventional single-unit packaging.	
Packaging Materials Internal External	Cushions and plastic bags made of low density polyethyler Outer carton, accessories carton, and insert made of corru		
Manageability			
	Intel® Xeon® W Processor Family	Intel [®] Core™ X-series Processors	
Industry Standard	This product meets the following industry standard	<u>None apply</u>	
Specifications	 specifications for manageability functionality: DASH 1.1 (via Intel[®] LAN on motherboard) 		
Intel Active Management Technology (AMT)	• DASH 1.1 (Via Intel® LAN on mother board) : Intel® Active Management Technology (AMT) 11.1x		
	An advanced set of remote management features		
	and functionality providing IT administrators the		
	latest and most effective tools to remotely		
	discover, heal, and protect networked client		
	systems regardless of the system's health or power state. AMT 11.1x includes the following advanced		
	management functions:		
	Power Management (on, off, reset,		
	graceful shutdown, sleep and hibernate)		
	 Support in Max Power Savings 		
	(Shutdown and Hibernate Modes)		
	Hardware Inventory (includes BIOS and		
	firmware revisions)		
	Hardware Alerting Acout Presence		
	Agent Presence Sustam Defense Filters		
	 System Defense Filters Serial Over LAN (SOL) 		

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core[™] X-series Processor Family CX (i7): Core i7-X series only CX (i9): Core i9-X series only

System Technical Specifications

Intel® vPro™ Technology	 USB Redirect (Media Redirection) ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled DASH 1.1 compliance IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre- schedule when the system connects to the IT or service provider console for maintenance. Remote Alerts - automatically alert IT or service provider if issues arise Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support Host Base set-up and configuration Management Engine (ME) firmware roll back Local Time Sync to UTC Remote Amory Dump Command – Creates memory dump for debug The HP Z4 G4 Workstation supports Intel® VPro™ Not supported technology when configured as outlined below: Intel® Xeon® processor W-2100 product family featuring Intel® vPro™ Technology Intel® (212) LM GbE LAN
Remote Manageability Software Solutions	The HP Z4 G4 Workstation is supported on the following optional remote manageability software consoles:
	 LANDesk Management Suite (HP recommended solution) Microsoft System Center Configuration Manager
	For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy
System Software Manager	For easydeploy questions or support for SSM, please visit: http://www.hp.com/go/ssm
Service, Support, and Warranty	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on- site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3)

Processor Supports: XW: Configurations with Intel[®] Xeon -W Processor Family CX: Configurations with Intel[®] Core™ X-series Processor Family CX (i7): Core i7-X

series only **CX (i9):** Core i9-X series only c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

System Technical Specifications

	8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
	NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.
	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.
Product Change Notification	 Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
	TBD	Intel [®] Xeon [®] W-2125 4.0 2666 4C CPU
	TBD	Intel® Xeon® W-2123 3.6 2666 4C CPU
	TBD	Intel® Xeon® W-2102 2.9 2400 4C CPU
Hard Drives	Product #	Offering
	LQ037AA	1TB SATA 7200 RPM
		.
Graphics	Product #	Offering
	2TF08AA	AMD Radeon™ Pro WX 3100 4GB Graphics
	Product #	Offering
Memory	TBD	Offering TBD
	TBD	TBD
	TBD	TBD
	TBD	ТВО
		עסו
Optical and Removable	Product #	Offering
Storage	TBD	TBD
	TBD	TBD

Processor Supports: XW: Configurations with Intel® Xeon -W Processor Family CX: Configurations with Intel® Core™ X-series Processor Family CX (i7): Core i7-X



Technical Specifications - Processors

Intel[®] Xeon[®] W-2100 Series CPU

Intel® Xeon® W-2195 2.3 2666 18C CPU Intel® Xeon® W-2175 2.5 2666 14C CPU Intel® Xeon® W-2155 3.3 2666 10C CPU Intel[®] Xeon[®] W-2145 3.7 2666 8C CPU Intel® Xeon® W-2135 3.7 2666 6C CPU Intel® Xeon® W-2133 3.6 2666 6C CPU Intel® Xeon® W-2125 4.0 2666 4C CPU Intel® Xeon® W-2123 3.6 2666 4C CPU Intel® Xeon® W-2104 3.2 2400 4C CPU Intel® Xeon® W-2102 2.9 2400 4C CPU Intel[®] Core[™] X-Series CPU Intel[®] Core[™] i9-9980XE 3.0 2666 18C CPU Intel[®] Core[™] i9-9920X 3.5 2666 12C CPU Intel[®] Core[™] i9-9820X 3.3 2666 10C CPU Intel[®] Core[™] i7-9800X 3.8 2666 8C CPU Intel[®] Core[™] i9-7980XE 2.6 2666 18C CPU Intel[®] Core[™] i9-7960X 2.8 2666 16C CPU Intel[®] Core[™] i9-7940X 3.1 2666 14C CPU Intel[®] Core[™] i9-7920X 2.9 2666 12C CPU Intel[®] Core[™] i9-7900X 3.3 2666 10C CPU Intel[®] Core[™] i7-7820X 3.6 2666 8C CPU Intel[®] Core[™] i7-7800X 3.5 2400 6C CPU

STORAGE/HARD DRIVES

HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations	HP 300GB SAS 15K SFF HDD	Capacity Height	300GB 5.9 in; 15 cm	
		Width Interface	Media Diameter	3.5 in; 8.9 cm
			12Gb/s SAS Up to 1200 MB/s (SAS s	ingle port)*
		Synchronous Transfer Rate (Maximum)	Up to 1200 Mb/S (SAS S	ingle por l)"
		Buffer	128MB	
		Seek Time (typical reads, includes controller overhead, including settling)	Average	2.0ms *
		Rotational Speed	15K rpm	
		Operating Temperature *Actual performance may	41° to 131° F (5° to 55° vary.	C)

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Technical Specifications - Hard Drives

SATA (Serial ATA) Hard Drives for HP Workstations	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Capacity Height Width Interface Synchronous Transfer Rate (Maximum) Buffer	500GB 1 in; 2.54 cm Media Diameter Physical Size Serial ATA (6.0Gb/s), NC Up to 600MB/s* 16MB	3.5 in; 8.9 cm 4 in; 10.17 cm Q enabled
		Seek Time (typical reads, includes controller overhead, including settling)	Single Track Average Full Stroke	2 ms* 11 ms* 21 ms*
		Rotational Speed	7,200 rpm	
		Logical Blocks	976,773,168	
		Operating Temperature	41° to 131° F (5° to 55° (C)
		*Actual performance may	vary.	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Capacity Height	1TB 1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), NC	Q enabled
		Synchronous Transfer Rate (Maximum)	Up to 600 MB/s*	
		Buffer	64MB	
		Cache	Adaptive	
		Seek Time (typical reads,	Single Track	2 ms*
		includes controller	Average	11 ms*
		overhead, including settling)	Full Stroke	21 ms*
		Rotational Speed	7,200 rpm	
		Operating Temperature	41° to 131° F (5° to 55° (C)
		*Actual performance may	vary.	
	2.0TB SATA 7200 rpm	Capacity	2.0TB	
	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0 Gb/s), NO	Q Enabled
		Synchronous Transfer Rate (Maximum)	Up to 600 MB/s*	
		Buffer	64MB	
		Seek Time (typical reads,	Single Track	1.0 ms*
		includes controller	Average	11 ms*
			Full Stroke	18 ms*

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors.

	overhead, including			
	settling) Rotational Speed	7 200 rpm		
	-	7,200 rpm		
	Logical Blocks	3,907,029,168	-)	
	Operating Temperature		_)	
	*Actual performance may v	Vdry.		
1TB SATA 7200 rpm	Capacity	1TB		
6Gb/s 3.5" HDD	Protocol	SATA		
(Enterprise Class)	Form Factor	3.5"		
	Controller	AHCI		
	Reliability (MTBF)	2.0M hours		
	Rated Power On Hours	8760/yr		
	Annualized Failure Rate (based on Rated POH)	<0.62%		
	Rated for 24/7/365 operation	YES		
	Physical Size (Height)	1 in; 2.54 cm		
	Physical Size (Width)	4 in; 10.17 cm		
	Media Diameter	3.5 in; 8.9 cm		
	Interface	Serial ATA (6Gb/s), NCQ	enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*		
	Buffer	128MB		
	Seek Time (typical reads,	Single Track	0.32ms*	
	includes controller	Average	7.45ms*	
	overhead, including settling)	Full Stroke	14.2ms*	
	Operating Temperature	41° to 140° F (5° to 60° (C)	
	Performance	Sequential Read	up to 226MB/s*	
		Sequential Write	up to 226MB/s*	
	Enterprise Class Features	B High Reliability		

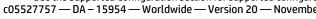
*Actual performance may vary.

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.
See the Supported Configuration section for supported configurations.

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4TB SATA 7200 rpm		4TB	
6Gb/s 3.5" HDD (Enterprise Class)	Height	0.275 in; 0.7 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6Gb/s), N	CQ enabled
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Buffer	128MB	
	Seek Time (typical reads,	Single Track	0.7ms*
	includes controller	Average	8.5ms*
	overhead, including settling)	Full Stroke	15.7ms*
	Rotational Speed	7,200 rpm	
	Operating Temperature	32° to 140° F (0° to 6	0° C)
	*Actual performance may	vary.	
500GB SATA 7.2K SI	D Capacity	500GB	
SFF HDD			
SFF HDD	Height Width	0.275 in; 0.7 cm Media Diameter	2.5 in; 6.36 cm
SFF HDD	Height	0.275 in; 0.7 cm Media Diameter	2.5 in; 6.36 cm 2.75 in; 6.99 cm
SFF HDD	Height	0.275 in; 0.7 cm	2.5 in; 6.36 cm 2.75 in; 6.99 cm
SFF HDD	Height Width	0.275 in; 0.7 cm Media Diameter Physical Size	
SFF HDD	Height Width Interface Synchronous Transfer	0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s)	
SFF HDD	Height Width Interface Synchronous Transfer Rate (Maximum)	0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s) Up to 600MB/s*	
SFF HDD	Height Width Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, includes controller	0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s) Up to 600MB/s* 32MB	2.75 in; 6.99 cm
SFF HDD	Height Width Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads,	0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s) Up to 600MB/s* 32MB Single Track	2.75 in; 6.99 cm 1ms*
SFF HDD	Height Width Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, includes controller overhead, including	0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s) Up to 600MB/s* 32MB Single Track Average	2.75 in; 6.99 cm 1ms* 4.2ms*
SFF HDD	Height Width Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, includes controller overhead, including settling)	0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s) Up to 600MB/s* 32MB Single Track Average Full Stroke	2.75 in; 6.99 cm 1ms* 4.2ms* 25ms (typical)*

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors. See the Supported Configuration section for supported configurations. 卿 c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019 Page 43



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Technical Specifications - Hard Drives

SATA SSDs for HP Workstations	HP 256GB SATA 6Gb/s SSD	Capacity	256GB	
Workstations	550	Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	
		Endurance	192TBW (TB Written)	
		Reliability (MTTF)	1.5M hours	
		Physical Size (Height)	0.28 in; 0.7 cm	
		Physical Size (Width)	2.5 in; 6.36 cm	
		Interface	SATA 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
		Operating Temperature	32° to 158° F (0° to 70°	C)
		Performance	Sequential Read	530MB/s (max)*
			Sequential Write	500MB/s (max)*
			Random Read	55K IOPS (max)*
			Random Write	83K IOPS (max)*
		*Actual performance may	vary.	
	HP 256GB SATA 6Gb/s SED Opal 2 SSD	Capacity	256GB	
		Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	
		Endurance	192TBW (TB Written)	
		Reliability (MTTF)	1.5M hours	
		Physical Size (Height)	0.28 in; 0.7 cm	
		Physical Size (Width)	2.5 in; 6.36 cm	
		Interface	6Gb/s SATA	
		Synchronous Transfer	Up to 550MB/s (Sequential Read)*	
		Rate (Maximum)		-
		Operating Temperature	32° to 158° F (0° to 70°	
		Performance	Sequential Read	530MB/s*
			Sequential Write	500 MB/s*
			Random Read	55K IOPS*
			Random Write	83K IOPS*
		Self-Encrypting Drive Support	OPAL 2	
		*Actual performance may	vary.	
	HP 512GB SATA 6Gb/s	Capacity	512GB	
	SSD	Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.

	Endurance	388TBW (TB Written)	
	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequen	itial Read)*
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	530 MB/s*
		Sequential Write	500 MB/s*
		Random Read	95K IOPS*
		Random Write	83K IOPS*
	*Actual performance may v	/ary.	
HP 512GB SATA SED SSD	Capacity	512GB	
	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	388TBW (TB Written)	
	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	530 MB/s*
		Sequential Write	500 MB/s*
		Random Read	95K IOPS*
		Random Write	83K IOPS*
	Self-Encrypting Drive Support	OPAL 1 and 2	
	*Actual performance may v	/ary.	
HP 1TB SATA 6Gb/s SSD	Capacity	1TB	
	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	

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Technical Specifications - Hard Drives

	Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequer	ntial Read)*
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	530 MB/s*
		Sequential Write	500 MB/s*
		Random Read	95K IOPS*
		Random Write	83K IOPS*
	*Actual performance may	vary.	
HP 2TB SATA 6Gb/s SSD	Capacity	2TB	
	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer	Up to 550MB/s (Sequer	ntial Read)*
	Rate (Maximum)		
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	530 MB/s*
		Sequential Write	500 MB/s *
		Random Read	95K IOPS*
		Random Write	83K IOPS*
	*Actual performance may	vary.	
HP Enterprise Class	Capacity	240GB	
240GB SATA SSD	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	2,200TBW (TB Written)	
	Reliability (MTTF)	2.0M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	6Gb/s SATA	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	540 MB/s*
		Sequential Write	310 MB/s*
		Random Read	93K IOPS*
		Random Write	48K IOPS*

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.

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		Enterprise Class Features	High Endurance NANE Power Loss Protectio End-to-End Data Prot	n
		*Actual performance may v	vary.	
	HP Enterprise Class	Capacity	480GB	
	480GB SATA SSD	Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	
		Endurance	4,400TBW (TB Writter	n)
		Reliability (MTTF)	2.0M hours	
		Physical Size (Height)	0.28 in; 0.7 cm	
		Physical Size (Width)	2.5 in; 6.36 cm	
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
		Operating Temperature	32° to 158° F (0° to 70	D° C)
		Performance	Sequential Read	540 MB/s*
			Sequential Write	460 MB/s*
			Random Read	93K IOPS*
		Random Write	74K IOPS*	
		Enterprise Class Features	High Endurance NANE Power Loss Protectio End-to-End Data Prot	n
		*Actual performance may v	vary.	
PCIe SSDs for HP	HP Z Turbo Drive G2	Capacity	256GB	
Workstations	256GB SSD	Protocol	PCIe	
		Form Factor	M.2	
		Controller	NVMe	
		NAND Type	MLC	
		Endurance	150TB	
		Reliability (MTBF)	1.5M hours	
		Interface	PCI Express 3.0 x4 electrical x4 physica	
		Operating Temperature	32° to 158° F (0° to 70	D° C)
		Performance	Sequential Read	2800 MB/s *
			Sequential Write	1100 MB/s *
			Random Read	250K IOPS *
			Random Write	180K IOPS *
		*Actual performance may v	vary.	
	HP Z Turbo Drive G2	Capacity	512GB	
	512GB SSD	Protocol	PCIe	
		Form Factor	M.2	

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors.

See the Supported Configuration section for supported configurations. c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

Controller	NVMe	
NAND Type	3D MLC	
Endurance	300TB	
Reliability (MTBF)	1.5M hours	
Interface	PCI Express 3.0 x4 ele	ctrical x4 physical
Operating Temperature	32° to 158° F (0° to 70	о°С)
Performance	Sequential Read	2800 MB/s*
	Sequential Write	1600 MB/s*
	Random Read	260K IOPS*
	Random Write	260K IOPS*

*Actual performance may vary.

HP Z Turbo Drive G2 1TB	Capacity	1TB	
SSD	Protocol	PCle	
	Form Factor	M.2	
	Controller	NVMe 3D MLC 600TB 1.5M hours PCI Express 3.0 x4 electrical x4 physical 32° to 158° F (0° to 70° C)	
	NAND Type		
	Endurance		
	Reliability (MTTF)		
	Interface		
	Operating Temperature		
	Performance	Sequential Read	3000 MB/s*
		Sequential Write	1700 MB/s*
		Random Read	360K IOPS*
		Random Write	330K IOPS*
	*Actual performance may	varv.	

Actual performance may vary.

HP Z Turbo Drive Quad	Capacity	512GB	
Pro 2x256GB PCIe SSD	Protocol	PCIe	
	Form Factor	PCIe Card, Full Height PCIe Slot	
	Controller	NVMe	
	NAND Type	MLC	
	Endurance	150TB	
	Reliability (MTBF)	1.5M hours	
	Interface	PCIe Gen3 x4 architecture	
	Operating Temperature	32° to 158° F (0° to 70° C)	
	Performance	Sequential Read	2800 MB/s*
		Sequential Write	1100 MB/s*
		Random Read	250K IOPS*
		Random Write	180K IOPS*
	*Actual performance may v	/ary.	

HP Z Turbo Drive Quad Pro 2x512GB PCIe SSD	Capacity	1TB	
	Protocol	PCle	
	Form Factor	PCIe Card, Full Height P	Cle Slot
	Controller	NVMe	
	NAND Type	MLC	
	Endurance	292TB	
	Reliability (MTBF)	1.5M hours	
	Interface	PCIe Gen3 x4 architecture	
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	2800 MB/s*
		Sequential Write	1600 MB/s*
		Random Read	250 K IOPS*

Random Write

180K IOPS*

*Actual performance may vary.

HP Z Turbo Drive G2	Capacity	256GB	
256GB SED SSD	Protocol	PCIe	
	Form Factor	Form Factor Half-height, half-length	
	Controller NVMe		
	NAND Type	MLC	
	Endurance	150TBW (TB Written)	
	Reliability (MTBF)	1.5M hours PCI Express 3.0 x4 electrical x4 physica	
	Interface		
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	2800 MB/s*
		Sequential Write	1100 MB/s*
		Random Read	250K IOPS*

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors. See the Supported Configuration section for supported configurations.

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Technical Specifications - Hard Drives

		Random Write	180K IOPS*	
	Self-Encrypting Drive Support	OPAL 2		
	*Actual performance may v	ary.		
HP Z Turbo Drive G2	Capacity	512GB		
512GB SED SSD	Protocol	PCIe		
	Form Factor	Half-height, half-length		
	Controller	NVMe		
	NAND Type	3D MLC		
	Endurance	300TBW (TB Written)		
	Reliability (MTBF)	1.5M hours		
	Interface	PCI Express 3.0 x4 electi	rical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70° (<u>(</u>)	
	Performance	Sequential Read	2800 MB/s*	
		Sequential Write	1600 MB/s*	
		Random Read	260K IOPS*	
		Random Write	150K IOPS*	
	Self-Encrypting Drive Support	OPAL 2		
	*Actual performance may v	vary.		
HP Z Turbo Drive Quad Pro	Capacity	2TB		
2x1TB PCIe SSD	Protocol	PCle		
	Form Factor	PCIe Card, Full Height PC	le Slot	
	Controller	NVMe		
	NAND Type	3D MLC		
	Endurance	600TB		
	Interface	PCI Express 3.0 x4 electi	rical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70° (<u>_</u>)	
	Performance	Sequential Read	3000 MB/s*	
		Sequential Write	1700 MB/s*	
		Random Read	360K IOPS*	
		Random Write	330K IOPS*	
	*Actual performance may	vary.		
HP Z Turbo Drive G2	Capacity	256GB		
256GB TLC SSD	Protocol	PCIe		
	Form Factor	M.2		
	Controller	NVMe		
	NAND Type	3D TLC		
	Endurance	75TBW (TB Written)		
	Reliability (MTBF)	1.5M hours		
	Interface	PCI Express 3.0 x4 electr	rical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70° (_)	

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors. See the Supported Configuration section for supported configurations.

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Technical Specifications - Hard Drives			
reclinical specifications - hard brives			_
	Performance	Sequential Read	2800 MB/s*
		Sequential Write	320 MB/s (1100 MB/s max/Turbo)*
		Random Read	250K IOPS*
		Random Write	180K IOPS*
	*Actual performance may	vary.	
HP Z Turbo Drive G2	Capacity	512GB	
512GB TLC SSD	Protocol	PCle	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	150TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 elec	trical x4 physical
	Operating Temperature	32° to 158° F (0° to 70°	° C)
	Performance	Sequential Read	2800 MB/s*
		Sequential Write	660 MB/s (1600 MB/s max/Turbo)*
		Random Read	260K IOPS*
		Random Write	260K IOPS*
	*Actual performance may	vary.	
HP Z Turbo Drive G2 1TB	Capacity	1TB	
TLC SSD	Protocol	PCIe	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	300TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 elec	
	Operating Temperature	32° to 158° F (0° to 70°	
	Performance	Sequential Read	3000 MB/s*
		Sequential Write	1150 MB/s (1700 MB/s max/Turbo)*
		Random Read	360K IOPS*
		Random Write	330K IOPS*
	*Actual performance may	vary.	
HP Z Turbo Drive G2 2TB	Capacity	2TB	
TLC SSD	Protocol	PCIe	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.

600TBW (TB Written)

Endurance

	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 elect	trical v4 physical
	Operating Temperature	32° to 158° F (0° to 70°	
	Performance	Sequential Read	3000 MB/s*
	renormance	Sequential Write	1000 MB/s (2100 MB/s
		Sequencial write	max/Turbo)*
		Random Read	320K IOPS*
		Random Write	265K IOPS*
	*Actual performance may	vary.	
HP Z Turbo Drive Dual	Capacity	256GB	
Pro 256GB SSD	Protocol	PCIe	
	Form Factor	M.2 in Half-height, half	-length card
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	75TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 elect	trical x4 physical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	2800 MB/s*
		Sequential Write	320 MB/s (1100 MB/s max/Turbo)*
		Random Read	250K IOPS*
		Random Write	180K IOPS*
	*Actual performance may v	/ary.	
HP Z Turbo Drive Dual	Capacity	512GB	
Pro 512GB SSD	Protocol	PCIe	
	Form Factor	M.2 in Half-height, half	-length card
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	150TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 elect	trical x4 physical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	2800 MB/s*
		Sequential Write	660 MB/s (1600 MB/s max/Turbo)*
		Random Read	260K IOPS*
		Random Write	260K IOPS*
	*Actual performance may v	/ary.	

Capacity

1TB

QuickSpecs

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Technical Specifications - Hard Drives

	HP Z Turbo Drive Dual Pro 1TB SSD	Protocol	PCIe	
		Form Factor	M.2 in Half-height, half	-length card
		Controller	NVMe	
		NAND Type	3D TLC	
		Endurance	300TBW (TB Written)	
		Reliability (MTBF)	1.5M hours	
		Interface	PCI Express 3.0 x4 elec	
		Operating Temperature	32° to 158° F (0° to 70°	-
		Performance	Sequential Read	3000 MB/s*
			Sequential Write	1150 MB/s (1700 MB/s max/Turbo)*
			Random Read	360K IOPS*
			Random Write	330K IOPS*
		*Actual performance may	vary.	
HP Z Turbo Drive Dual Pro 2TB SSD	Capacity	2TB		
	Pro 2TB SSD	Protocol	PCle	
	Form Factor	M.2 in Half-height, half	f-length card	
		Controller	NVMe	-
	NAND Type	3D TLC		
	Endurance	300TBW (TB Written)		
	Reliability (MTBF)	1.5M hours		
		Interface	PCI Express 3.0 x4 elec	trical x4 physical
		Operating Temperature	32° to 158° F (0° to 70°	' C)
		Performance	Sequential Read	3000 MB/s*
			Sequential Write	1150 MB/s (1700 MB/s max/Turbo)*
			Random Read	360K IOPS*
			Random Write	330K IOPS*
		*Actual performance may	vary.	
Intel [®] 905p Series AIC	Intel® 905p Series AIC	Capacity	280GB	
PCIe SSD	280GB PCIe SSD	Protocol	PCIe	
		Form Factor	PCIe Card, Half Height	
		Controller	NVMe	
		NVM Туре	3DXPoint	
		Endurance	5.11 PBW (PB Written)	
		Reliability (MTBF)	1.6M hours	
		Operating Temperature	32° to 185° F (0° to 85°	, C)
		Performance	Sequential Read	2730 MB/s*
			Sequential Write	2280 MB/s*
			Random Read	587K IOPS*

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors.

Random Write

559K IOPS*

	*Actual performance may	vary.	
Intel [®] 905p Series AIC	Capacity	480GB	
480GB PCIe SSD	Protocol	PCIe	
	Form Factor	PCIe Card, Half Height	
	Controller	NVMe	
	NVM Туре	3DXPoint	
	Endurance	8.76 PBW (PB Written)	
	Reliability (MTBF)	1.6M hours	
	Operating Temperature	32° to 185° F (0° to 85°	° C)
	Performance	Sequential Read	2710 MB/s*
		Sequential Write	2280 MB/s*
		Random Read	582K IOPS*
		Random Write	561K IOPS*
	*Actual performance may	vary.	

 Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors. See the Supported Configuration section for supported configurations.

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Technical Specifications - Hard Drive Controllers

HARD DRIVE CONTROLLERS

MicroSemi 2100-4i4e 8- port SAS 12Gb/s RAID Card	PCI Bus RAID Levels PCI Data Burst Transfer Rate	8 lanes, PCI Express 3.0 Offers Integrated RAID (0, 1, and 10) Half Duplex x8, PCIe, 8000 MB/s	
	SAS Bandwidth	Half Duplex	1200 MB/s per lane
	PCI Card Type	3.3V Add-in Card	
	PCI Voltage	12 V ± 10%	
	PCI Power	9.8W typical, Airflow min 200 LFM	
	Bracket	Full height and low profile	
	Certification Level	PCI Express 3.0 compliant	
	SAS Processor	MicroSemi Series 8 SAS Controller One x4 internal mini-SASHD (SFF-8643) One x4 external mini-SASHD (SFF-8644)	
	Internal Connectors		
	External Connectors		
	Maximum Number of SCSI Devices	256 Non-RAID SAS/SATA devices	
	LED Indicators	Connector for Drive Activity Light	

QuickSpecs

Technical Specifications - Graphics

GRAPHICS

NVIDIA® Quadro® P400 2GB Graphics	Form Factor	Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P400 Graphics Card GPU: 256 CUDA cores Power: 30 Watts Cooling: Active
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s
	Connectors	3mDP Outputs*
	Maximum Resolution	DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	3 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL
	Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7 Linux
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	*P400, P600 and P1000 only have mini-DisplayPort™ (mDP) video ports.
		Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit:Two mDP-to-DP Adapters included
		Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories: - 2MY05AA - HP miniDP-to-DP Adapter Cables - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Form Factor

Dimensions: 2.713" H x 5.7" L

NVIDIA® Quadro® P620 2GB Graphics		Single Slot, Low Profile Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P620 Graphics Card GPU: 512 CUDA cores Power: 40 Watts Cooling: Active
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 2 GB GDDR5, 2000 MHz Memory Interface: 128-bit Memory Bandwidth: 64 GB/s
	Connectors	4mDP Outputs *
	Maximum Resolution	DisplayPort™ 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	4 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL
	Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7 Linux
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	*P620 only have mini-DisplayPort™ (mDP) video ports.
		Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit:Two mDP-to-DP Adapters included
		Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories: - 2MY05AA - HP miniDP-to-DP Adapter Cables - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables
NVIDIA® Quadro® P1000 4GB Graphics	Form Factor	Dimensions:2.713" H x 5.7" L Single Slot, Low Profile Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P1000 Graphics Card GPU: 640 CUDA cores

		Power: 47 WattsCooling: Active Cooling: Active
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 4 GB GDDR5, 2500 MHz Memory Interface: 128-bit memory interface Memory Bandwidth: 80 GB/s memory bandwidth
	Connectors	4mDP Outputs*
	Maximum Resolution	DisplayPort 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	4 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL
	Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7 Linux
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	*P400, P600 and P1000 only have mini-DisplayPort™ (mDP) video ports.
		Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit:Two mDP-to-DP Adapters included
		And market option kit. Two more to be Adapters included
		Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories: - 2MY05AA - HP miniDP-to-DP Adapter Cables - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables
NVIDIA® Quadro® P2000 5GB Graphics	Form Factor	Dimensions: 4.4"H x 7.9"L Single Slot Weight: 260 grams
	Graphics Controller	NVIDIA® Quadro® P2000 Graphics Card Power: 75 Watts Cooling: Active
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 5GB GDDR5 Memory Bandwidth: 140 GB/s

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors.

See the Supported Configuration section for supported configurations. c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

Connectors	Memory Width: 160-bit 4x DisplayPort™ 1.4
	Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included
Maximum Resolution	Additional DVI to VGA, DisplayPort [™] to VGA, DisplayPort [™] to DVI, and DisplayPort [™] to Dual-Link DVI adapters available as accessories. DisplayPort [™] : - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready.
	DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz
	Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz
	HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz
Image Quality Features	12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection)
	Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView.
Display Output	Maximum number of displays - 4 direct attached monitors
	Maximum number of monitors across all available NVIDIA® Quadro® P2000 outputs is 4.
Shading Architecture	Shader Model 5.1
Supported Graphics APIs	OpenGL [®] 4.5 DirectX [®] 12
Available Graphics Drivers	API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software Microsoft Windows 10 Microsoft Windows 7 Professional 64bit
	Linux [®] - Full OpenGL [®] implementation, complete with NVIDIA [®] Quadro [®] and ARB extensions
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
Notes	 Quadro P2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. Quadro P2000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® P2200 5GB Graphics	Form Factor	Dimensions: 4.4"H x 7.9"L Single Slot, Full Height Weight: 260 grams
	Graphics Controller	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit
	Connectors	4x DisplayPort™ 1.4
		Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included
		Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	DisplayPort™: - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready.
		DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz
		Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz
		HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz
	Image Quality Features	12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection)
		Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView.
	Display Output	Maximum number of displays - 4 direct attached monitors
		Maximum number of monitors across all available NVIDIA® Quadro® P2200 outputs is 4.
	Shading Architecture	Shader Model 5.1
	Supported Graphics APIs	OpenGL [®] 4.5 DirectX [®] 12
		API support includes:

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Technical Specifications - Graphics		
	Available Graphics Drivers	CUDA C, CUDA C++, DirectCompute 5.0, OpenCL [™] , Java, Python, and Fortran software Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux [®] - Full OpenGL [®] implementation, complete with NVIDIA [®] Quadro [®] and ARB extensions
	Notes	 HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1. Quadro P2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro P2200 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.
Radeon™ Pro WX 3100	Form Factor	Low-Profile Single Slot (6.6" Length)
4GB Graphics	Graphics Controller	Radeon™ Pro WX 3100 Graphics Card GPU: 512 Stream Processors organized into 8 Compute Units Power: 50 Watts Cooling: Active
	Memory	4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit
	Connectors	2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.
		Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included
		Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	5K support @ 60Hz • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 3x 4K support @ 60Hz
	Image Quality Features	Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	3 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
	GPU Architecture	Polaris
	Supported Graphics APIs	DirectX°12 OpenGL° 4.5 OpenCL™ 2.0 Vulkan™ 1.0
	Available Graphics Drivers	Windows 10 64-bit (Windows® 7 64-bit available from AMD)

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Technical Specificat	ions - Graphics	
		Linux [®] 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
Radeon™ Pro WX 3200	Form Factor	Low-Profile Single Slot (2.75 "H x 6.6" L)
4GB Graphics	Graphics Controller	Radeon™ Pro WX 3100 Graphics Card GPU: 640 Stream Processors organized into 8 Compute Units Power: 56 Watts Cooling: Active
	Memory	4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit
	Connectors	2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.
		Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included
		Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 3x 4K support @ 60Hz
	Image Quality Features	Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	3 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel[®] Xeon[®] W processors and with Intel[®] Core[™] X-Series processors.

	GPU Architecture Supported Graphics APIs Available Graphics Drivers	Polaris DirectX°12 OpenGL° 4.5 OpenCL™ 2.0 Vulkan™ 1.0 Windows 10 64-bit (Windows® 7 64-bit available from AMD) Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
WX 4100	Form Factor Graphics Controller Memory	Low-Profile Single Slot (6.6" Length) Radeon™ Pro WX 4100 Graphics card GPU: 1024 Stream Processors organized into 16 Compute Units Power: 50 Watts Cooling: Active 4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s
	Connectors	Memory Width: 128 bit 4x Mini DisplayPort [™] 1.4 – HDR ready connectors with HBR3 and MST support. Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included
	Maximum Resolution	 Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories. 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.

See the Supported Configuration section for supported configurations. c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

Radeon™ Pro 4GB Graphics

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Technical Specifications - Graphics

		4x 4K support @ 60Hz
	Image Quality Features	Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
	GPU Architecture	GCN 4th Generation
	Supported Graphics APIs	DirectX°12 OpenGL° 4.5 OpenCL™ 2.0 Vulkan™ 1.0
	Available Graphics Drivers	Windows 10 64-bit Windows® 7 64-bit Linux® 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windows mode content requires operating system support.
		Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit: Four mDP-to-DP Adapters included
		Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories: 10. 2MY05AA - HP miniDP-to-DP Adapter Cables 11. 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables
NVIDIA® Quadro® P4000 8GB Graphics	Form Factor	Dimensions: 4.4"H x 9.5"L Single-slot, full-height Weight: 475 grams (without extender)
	Graphics Controller	NVIDIA® Quadro® P4000 Graphics Card

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Technical Specifications - Graphics

	GPU: 1792 CUDA cores Power: 120 Watts Cooling: Active
Bus Type Memory	PCI Express 3.0 x16 Size: 8GB GDDR5 Memory Bandwidth: 243 GB/s Memory Width: 256-bit
Connectors	4 x DisplayPort 1.4 3-pin mini-DIN connector via optional bracket 1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II 2 x SLI connectors
	Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included
	Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to- DVI adapters are available as accessories
Maximum Resolution	Dual-link internal TMDS (DVI 1.0): - up to 2560 x 1600 x 32 bpp @ 60 Hz
	Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz
	HDMI™ 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz
	DisplayPort: - up to 4096 x 2160 x 30 bpp @ 60Hz - up to 2560 x 1600 x 30 bpp @ 120 Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)
	Using two DP outputs, the P4000 can drive one dual DP input display with 5120 x 2880 x 30 bpp @ 60Hz resolution.
Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA Mosaic and nView
Display Output	Maximum number of displays - 4 direct attached monitors
Shading Architecture Supported Graphics APIs	Maximum number of monitors across all available Quadro P4000 outputs is 4. Shader Model 5.1 OpenGL 4.5 DirectX 12 Vulcan 1.0

	Available Graphics Drivers Notes	 API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran Microsoft Windows 10 Microsoft Windows 7 Linux® - Full OpenGL implementation, complete with NVIDIA and ARB extensions HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.
NVIDIA® Quadro® P5000 16GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 815 grams / 1.80 lbs
	Graphics Controller	NVIDIA® Quadro® P5000 graphics GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores Power: 180 Watts Cooling: Active
	Memory	16GB GDDR5X memory Memory Bandwidth: Up to 288 GB/s Memory Width: 256 bit ECC Memory (disabled by default)
	Connectors	DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector SLI connector NVIDIA® Quadro® Sync connector (compatible with NVIDIA® Quadro® II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

	Image Quality Features Display Outputs ¹	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA® 3D Vision [™] and other 3D stereo technologies NVIDIA Mosaic and nView Desktop Management 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz)
	GPU Architecture	NVIDIA Pascal™
	Supported Graphics APIs	DirectX®12 , OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows 10 64-bit Windows® 7 64-bit Linux® 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site:
	Notes	http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays
NVIDIA® Quadro® P6000 24GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 967 grams / 2.14 lbs
	Graphics Controller	NVIDIA® Quadro® P6000 graphics GPU: 3840 NVIDIA® CUDA® Parallel Processing Cores Power: 250 Watts Cooling: Active
	Memory	24GB GDDR5X memory Memory Bandwidth: Up to 432 GB/s Memory Width: 384 bit ECC Memory (disabled by default)

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors. See the Supported Configuration section for supported configurations. c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019



	Connectors	DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector SLI connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort [™] to VGA, DisplayPort [™] to DVI, and DisplayPort [™] to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA Mosaic and nView
	Display Outputs ¹	4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz)
	GPU Architecture	NVIDIA Pascal™
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site:
	Notes	http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays
NVIDIA® Quadro® GP100 16GB Graphics	Form Factor	Dual Slot (4.4" Height x 10.5" Length) Weight: 989 grams +72 grams extender

Graphics Controller	NVIDIA® QUADRO® GP100 GPU: 3584 NVIDIA CUDA® Parallel Processing Cores Power: 235 Watts Cooling: Active
Memory	16GB HBM2 Memory Bandwidth: Up to 717 GB/s Memory Width: 4096-bit ECC Memory (disabled by default)
Connectors	DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink connectors Factory configured option: 8-pin power adapter included with card. After market option Kit: 8-pin power adapter included with card. DVI to VGA, DisplayPort [™] to VGA, DisplayPort [™] to DVI, and DisplayPort [™] to Dual-Link DVI adapters available as accessories.
Maximum Resolution	5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors
Image Quality Features	HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA 3D Vision™ technology NVIDIA Mosaic and nView Desktop Management
Display Outputs	4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz) 1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz) HDMI™ 2.0b (up to 5120 x 2880 @ 60Hz)* *requires DP to HDMI adapter
GPU Architecture	NVIDIA Pascal™
Supported Graphics APIs	DirectX®12 , OpenGL® 4.5, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA (C++, DirectCompute
5.0, OpenCL, Java, Python, and Fortran	

Available Graphics Drivers	Windows® 10 Windows® 7 Professional 64-bit Linux®	
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html	
	Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included	

After market option kit: No adapters included

NVIDIA® Quadro® GV100 32GB Graphics	Form Factor Graphics Controller	Dual Slot (4.4" Height x 10.5" Length) Weight: 980 grams + 72 grams extender NVIDIA® QUADRO® GV100 GPU: 5120 NVIDIA® CUDA® Parallel Processing Cores Power: 250 Watts Cooling: Active
	Memory	32GB HBM2 memory Memory Bandwidth: Up to 870 GB/s Memory Width: 5120-bit ECC Memory (disabled by default)
	Connectors	DP (x4) with HDR support 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink for GV100 connectors (via optional kit) After market option Kit: no power adapter included with card. DisplayPort [™] to VGA, DisplayPort [™] to DVI (single-link and dual-link), and DisplayPort [™] to HDMI adapters available as accessories.
	Maximum Resolution	5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

	Image Quality Features	HDR support over DisplayPort [™] 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort [™] and HDMI connectors NVIDIA 3D Vision [™] technology NVIDIA Mosaic and nView Desktop Management
	Display Outputs	4x DP1.4 HDR2 outputs (up to 5120 x 2880 @ 60Hz)
	GPU Architecture	NVIDIA [®] Volta™
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Windows® 8 & 8.1 64-bit Windows® 7 64-bit Linux® 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		Factory Configured (Z4/Z8 G4 Workstation): No adapters included After market option kit: No adapters included
NVIDIA® Quadro® RTX 4000 8GB Graphics	Form Factor	Full-Height Single Slot (4.4" Height x 9.5" Length) Weight: 550 grams / 1.21 lbs
	Graphics Controller	NVIDIA® Quadro® RTX 4000 Graphics IGPU: 2304 NVIDIA® CUDA® Parallel Processing Cores Power: 160 Watts Cooling: Active
	Memory	8GB GDDR6 memory Memory Bandwidth: Up to 416 GB/s Memory Width: 384 bit

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors. See the Supported Configuration section for supported configurations. c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019



Connectors	3x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector	
	Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.	
	DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ t Dual-Link DVI adapters available as accessories.	
Maximum Resolution	7680x4320 @ 60Hz	
Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView	
Display Outputs ¹	3x DP 1.4a and VirtualLink ² (7680x4320 @ 60Hz)	
Supported Graphics APIs	DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran	
Available Graphics Drivers	Windows [®] 10 64-bit Linux [®] 64-bit	
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html	
Notes	 Supports up to a total of 4 displays VirtualLink's USB-C™ (data) cannot be disabled at a hardware level 	

NVIDIA® Quadro® RTX 5000 16GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 975 grams + 75 grams extender
	Graphics Controller	NVIDIA® QUADRO® RTX 5000 GPU: 3072 CUDA cores Power: 265 Watts Cooling: Active
	Memory	16GB HBM2 memory Memory Bandwidth: Up to 448 GB/s ECC Memory (disabled by default)

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.



Technical Specifications - Graphics

	Connectors	DP (x4) with HDR support 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink for RTX 5000 connectors (via optional kit)
		After market option Kit: no power adapter included with card.
I	Maximum Resolution	DisplayPort™ to VGA, DisplayPort™ to DVI (single-link and dual- link), and DisplayPort™ to HDMI adapters available as accessories. DisplayPort™ 1.4: 7680x4320 @ 60Hz
I	Image Quality Features	HDR support over DisplayPort [™] 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort [™] and HDMI connectors NVIDIA 3D Vision [™] technology NVIDIA Mosaic and nView Desktop Management
I	Display Outputs	4x DP1.4 HDR2 outputs (up to 7680x4320 @ 60Hz)
(GPU Architecture	NVIDIA [®] Volta™
9	GPU Architecture Supported Graphics APIs	NVIDIA® Volta™ DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
2	Supported Graphics	DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute
2	Supported Graphics APIs Available Graphics	DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran Windows® 10 64-bit Windows® 8 & 8.1 64-bit Windows® 7 64-bit
2	Supported Graphics APIs Available Graphics	DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran Windows® 10 64-bit Windows® 8 & 8.1 64-bit Windows® 7 64-bit Linux® 64-bit HP qualified drivers may be preloaded or available from the HP support Web site:

Technical Specifications - Graphics

NVIDIA® Quadro® RTX 6000 24GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 995 grams + 75 grams extender
	Graphics Controller	NVIDIA® QUADRO® RTX 6000 GPU: 4608 CUDA cores Power: 295 Watts Cooling: Active
	Memory	24GB HBM2 memory Memory Bandwidth: Up to 672 GB/s ECC Memory (disabled by default)
	Connectors	DP (x4) with HDR support 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink for RTX 5000 connectors (via optional kit) After market option Kit: no power adapter included with card. DisplayPort [™] to VGA, DisplayPort [™] to DVI (single-link and dual- link), and DisplayPort [™] to HDMI adapters available as accessories.
	Maximum Resolution	DisplayPort™ 1.4: 7680x4320 @ 60Hz
	Image Quality Features	HDR support over DisplayPort [™] 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort [™] and HDMI connectors NVIDIA 3D Vision [™] technology NVIDIA Mosaic and nView Desktop Management
	Display Outputs	4x DP1.4 HDR2 outputs (up to 7680x4320 @ 60Hz)
	GPU Architecture	NVIDIA [®] Volta™
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Windows® 8 & 8.1 64-bit Windows® 7 64-bit Linux® 64-bit

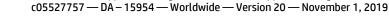
Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors. See the Supported Configuration section for supported configurations.

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Technical Specifications - Graphics

		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters
		included After market option kit: No adapters included
		*VirtualLink's USB-C™ (data) cannot be disabled at a hardware level
NVIDIA® Quadro® RTX 8000 48GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1070 grams / 2.35 lbs
	Graphics Controller	NVIDIA® Quadro® RTX 8000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active
	Memory	48GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit
	Connectors	4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector
		Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.
		DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	7680x4320 @ 60Hz
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView
	Display Outputs ¹	4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)
	Supported Graphics APIs	DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Technical Specificat	ions - Graphics	
		Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows [®] 10 64-bit Linux [®] 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 Supports up to a total of 4 displays VirtualLink's USB-C[™] (data) cannot be disabled at a hardware level
Radeon™ Pro WX 7100	Form Factor	Full-Height Single Slot (9.5" Length)
8GB Graphics	Graphics Controller	Radeon™ Pro WX 7100 graphics
		GPU: 2304 Stream Processors organized into 36 Compute Units
		Power: 130 Watts
		Cooling: Active
	Memory	8GB GDDR5 memory
		Memory Bandwidth: 7 Gbps / 224 GB/s
		Memory Width: 256 bit
	Connectors	4x Display Port 1.4 – HDR ready connectors with HBR3 and MST support.
		Factory Configured: No video cable adapter included
		After market option kit: No video cable adapter included
		Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	5K support @ 60Hz
		1x single-cable 5K monitor, or 2x dual-cable 5K monitors
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
	GPU Architecture	GCN 4th Generation
	Supported Graphics APIs	DirectX [®] 12
		OpenGL [®] 4.5
		OpenCL [™] 2.0
		Vulkan™ 1.0
	Available Graphics Drivers	Windows 10 64-bit Windows® 7 64-bit



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Technical Specificat	tions - Graphics	
		Linux [®] 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 12. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. 13. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro[™] GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice. 14. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. 15. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR
		and viewed with an HDR-ready player. Windowed mode content requires operating system support.
Radeon™ Pro WX 9100 16GB Graphics	Form Factor	Dual Slot (4.4" Height x 10.5" Length)
	Graphics Controller	Radeon™ Pro WX 9100 graphics

Graphics Controller	Radeon™ Pro WX 9100 graphics GPU: 4096 Stream Processors Power: 250 Watts Cooling: Active
Memory	16GB HBM2 memory Memory Bandwidth: Up to 483 GB/s Memory Width: 2048 bit
Connectors	6x Mini DisplayPort 1.4 – HDR ready connectors with HBR3 and MST support.
	Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

QuickSpecs

Technical Specifications - Graphics

	Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.		
Maximum Resolution	8K support @ 60Hz Single monitor, single or dual-cable		
Image Quality Features	Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling		
Display Output	6 full physical mDP 1.4 HDR Ready outputs FreeSync support		
GPU Architecture	Vega™		
Supported Graphics APIs	DirectX® 12.1 OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0		
Available Graphics Drivers	Windows 10 64-bit Windows 7 available from AMD Linux® 64-bit		
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html		
Notes	 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. 		
	 Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro[™] GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change 		
	without notice. 3. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro [™] and Radeon [™] Pro products, which are designed to intelligently manage GPU power consumption		
	 in response to certain GPU load conditions. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready 		

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® CoreTM X-Series processors. See the Supported Configuration section for supported configurations. c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019



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Technical Specifications - Graphics

content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included

After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories:

- 2MY05AA HP miniDP-to-DP Adapter Cables
- 2KW87A6 HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® Sync II	Part number Dimensions (HxD) Devices Supported	1WT20AA 6.0 inches × 4.2 inches NVIDIA® Quadro® P4000 NVIDIA® Quadro® P5000		
	Bus Type	NVIDIA® Quadro® P6000 Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector		
	PCI Form Factor	Full Height, half length, single slot		
	Ports	2 RJ45 connectors for carrying frame lock signals over CAT5 cables. BNC Connector for external house synchronization.		
	Internal Connectors	 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs Included with the board are 4 12-Inch Short Sync Cables to connect to GPU's Included with the board are 2 24-Inch Long Sync Cables to connect to GPU's 		
	System Requirements	Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards. Requires Quadro driver version R375 or later.		
	Temperature - Operating	0° to 55° C		
	Temperature - Storage	-40° to 60° C		
	Relative Humidity - Operating	10% to 80%		
	Power Requirements	Board power dissipation: <15W		
	Operating Systems Supported	Windows 10 64-bit Windows 7 64-bit Linux® 64-bit		
	Kit Contents	Contains: • Quadro Sync II Card • 4 x 12-Inch Short Sync Cables • 2 x 24-Inch Long Sync Cables (Two) • Quick Start Guide		

Quick Start Guide

QuickSpecs

Technical Specifications - Graphics

Technical Specifications – Optical and Removable Storage

OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim DVD Writer	Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types	9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm DVD+R DVD+RW DVD+RUL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
		Full Stroke DVD	< 200 ms (seek)
		Full Stroke CD	< 200 ms (seek)
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read	DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
	Power	Source	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC -< 800 mA typical, <1600 mA maximum
	Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
	(all conditions non-	Relative Humidity	10% to 80%
	condensing)	Maximum Wet Bulb Temperature	84° F (29° C)
	Kit Contents	HP SATA DVD Writer drive, installat	ion guide.
HP 9.5mm Slim DVD-ROM Drive	Description Mounting Orientation Interface Type Dimensions (WxHxD)	9.5mm height, tray-load Either horizontal or vertical SATA / ATAPI 128 x 9.5 x 127mm	
	Disc Capacity	DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.

See the Supported Configuration section for supported configurations. c05527757 — DA – 15954 — Worldwide — Version 20 — November 1, 2019

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	Access Times	DVD-ROM Single Layer	< 110 ms (typical)
		CD-ROM Mode 1	< 110 ms (typical)
		Full Stroke DVD	< 230 ms (typical)
		Full Stroke CD	< 220 ms (typical)
	Power	Source	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC – <800mA typical, < 1600 mA maximum
	Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
	(all conditions non-	Relative Humidity	10% to 80%
	condensing)	Maximum Wet Bulb Temperature	84° F (29° C)
	Kit Contents	9.5mm Slim DVD-ROM Drive, 5.25" data/power cable, installation guid	ODD Bay adapter/carrier, slim SATA e
P HH DVD Writer (16X	Description	HP Half Height DVD Writer	
W DVD-R)	Mounting Orientation	Either Horizontal or vertical	
	Interface Type	SATA	
	Dimensions (WxHxD)	146x42x165mm	
	Supported Media Types	DVD+R	
		DVD+RW	
		DVD+R DL DVD-R DL	
		DVD-R	
		DVD-RW	
		CD-R	
		CD-RW	
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
		Full Stroke DVD	145ms (seek)
		Full Stroke CD	120ms (seek)
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read	DVD+RW Up to 13X DVD-RW Up to 13X
			DVD+R DL Up to 12X
			DVD-R DL Up to 12X
			DVD-ROM Up to 12X
			DVD-ROM DL Up to 12X DVD+R Up to 16X
			DVD+R Up to 16X
	Power	Source	•
	Power	Source DC Power Requirements	SATA DC power receptacle 5 VDC ± 5% -100 mV ripple p-p
	Power		SATA DC power receptacle

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel[®] Xeon[®] W processors and with Intel[®] Core[™] X-Series processors.

QuickSpecs

Technical Specifications – Optical and Removable Storage

	Operating Environmental (all conditions non- condensing)	Relative Humidity	10% to 90% (Non-Condensing)	
	Operating Systems Supported	Windows 10, Windows 7 Professional 64-bit. Red Hat Enterprise Linux WS4**,5,6 Desktop/Workstation. No driver is required for this device, Native support is provided by operating system.		
	Kit Contents	HP SATA DVD Writer drive, Installa	tion guide.	
HP 9.5mm Slim BDXL Blu-	Description	9.5mm height, tray-load		
Ray Writer	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA/ATAPI		
	Dimensions (WxHxD)	128 x 9.5 x 127mm		
	Supported Media Types	BD-ROM BD-R BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-R DVD-RW CD-R CD-RW		
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard	
		Blu-ray	25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL)	
		Full Stroke DVD	< 230 ms (seek)	
		Full Stroke CD	< 220 ms (seek)	
		Blu-ray	< 230 ms (seek) (Full Stroke Blu-ray)	
		Startup Time	(Time to drive ready from tray loading) BD-ROM (SL/DL) 255 / 285 BD-R (SL/DL) 255 / 285 BD-RE (SL/DL) 255 / 285 DVD-ROM (SL/DL) 185 / 185 DVD-R (SL/DL) 255 / 255 DVD-RW 255 DVD+R (SL/DL) 255 / 255 DVD+RW 255 CD-ROM 155	
	Maximum Data Transfer Rates		CD-ROM, CD-R Up to 24X CD-RW Up to 24X	
		DVD ROM Read	DVD+RW Up to 8X DVD-RW Up to 8X	

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors. See the Supported Configuration section for supported configurations.

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Technical Specifications – Optical and Removable Storage

		Blu-ray	DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R Up to 6X BD-R Up to 6X BD-R Up to 6X
	Power	Source	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC -900 mA typical, 2000mA maximum
	Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
	(all conditions non-	Relative Humidity	10% to 80%
	condensing)	Maximum Wet Bulb Temperature	84° F (29° C)
	Kit Contents	9.5mm Slim BDXL Blu-Ray Writer, 5 SATA data/power cable, installation	
			d/or performance issues may arise, and duct. Flawless playback on all systems e Blu-ray titles to play, they may ction and your display may require
HP SD Card Reader	Description	Supports hardware ECC (Error Corre Supports hardware CRC (Cyclic Red Supports SD 4-bit parallel transfer	undancy Check) function
	Interface Type	USB 3.1 G1 High-speed interface	
	Dimensions (WxHxD)	1.15 x .9 x .15 in (29.00 x 23.6 x 3.1 Bay	5 mm) Fits conveniently in the Front IO
	Supported Media Types	Secure Digital Card (SD) Secure Digital High Capacity (SDHC) SD Extended Capacity Memory Card SD Ultra High Speed II(SD UHSII)	
		These additional media types are supported with a card adapter.	
		miniSD miniSD High Capacity Micro SD Memory Card (MicroSD) Micro SD High Capacity Memory Car	
	Kit Contents	±5% SD card reader	er applied, unit operating on system

Technical Specifications – Optical and Removable Storage

Approvals	USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT
Weight	0.35 lbs. (0.16 kg)

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 Technical Specifications - Controller Cards

CONTROLLER CARDS

HP Thunderbolt-3 Dual Port2 PCIe 1-port I/O Card	Data Transfer Rate	Supports up to 40 Gb/s (40,000 Mb/s)
	Devices Supported	Thunderbolt™, Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows devices
	Bus Type	PCIe Slot. Slot 4 only
	Ports	Two Thunderbolt™ 3 external USB type-C output connectors (Rear) Two full size DisplayPort input connectors (Rear)
	Internal Connectors	One 2x5-Pin header connector
	System Requirements	Genuine Windows 10 Professional 64-bit, slot 4 PCH PCIe slot.
	Temperature - Operating	50° to 131° F (10° to 55° C)
	Temperature - Storage	-22° to 140° F (-30° to 60° C)
	Relative Humidity - Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Genuine Windows 10 Professional 64-bit.
	Kit Contents	HP Thunderbolt™ 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO (General-Purpose Input/Output) cables, Installation documentation and warranty card.

*Maximum speed requires DisplayPort[™] and PCIe aggregation.

Technical Specifications - Networking and Communications

NETWORKING AND COMMUNICATIONS

Integrated Intel I219 PCIe GbE Controller	Connector Controller Data Rates Supported Boot ROM Support Connect Speed LED Indicators	RJ-45 Intel I219 GbE platform LAN connect networking controller 10/100/1000 Mbps PXE, UEFI Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Amber = 100Mbps • Green = 1000Mbps	
	Management Capabilities	Wake-On-LAN, Intel [®] Active Management Technology™ (AMT) 11.1x NOTE: Intel [®] AMT [™] is not available on Intel Core X configs.	
Integrated Intel I210	Connector	RJ-45	
(not available on Intel	Controller	Intel [®] I210	
Core X configs)	Data Rates Supported	10/100/1000 Mbps	
	Boot ROM Support	PXE, UEFI	
	Connect Speed LED Indicators	Link/Activity LED Off = No link Blinking = Activity Speed LED Off = 10Mbps Amber = 100Mbps Green = 1000Mbps	
	Management Capabilities Wake-On-LAN		
Intel® I210-T1	Networking Interface	RJ-45	
	System Interface	PCI Express 2.1 x1	
	Networking Speeds Supported	10Mbps, 100Mbps, 1Gbps	
	Cabling (up to 100m)	Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps	
	Power Consumption (active-typical)	0.81W	
	Physical Dimensions	Length: 6.7cm (2.64 inches) (Bracket) Width: 1.8cm (0.709 inches) Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches)	

Technical Specifications - Networking and Communications

	Connect Speed LED Indicators Operating Temperature Hardware Certifications	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps 0 °C to 55 °C (32 °F to 131 °F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003
Intel® I350-T2	Networking Interface	2 x RJ-45
	System Interface	PCI Express 2.1 x4
	Networking Speeds Supported	10Mbps, 100Mbps, 1Gbps
	Cabling (up to 100m)	Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps
	Power Consumption (active-typical)	4.4W
	Physical Dimensions	Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)
	Connect Speed LED Indicators	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps
	Operating Temperature Hardware Certifications	0°C to 55°C (32°F to 131°F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003

Intel® I350-T4

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Networking Interface 4 x RJ-45

Technical Specifications - Networking and Communications

	System Interface	PCI Express 2.1 x4
	Networking Speeds Supported	10Mbps, 100Mbps, 1Gbps
	Cabling (up to 100m)	Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps
	Power Consumption (active-typical)	5W
	Physical Dimensions	Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)
	Connect Speed LED Indicators	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps
	Operating Temperature Hardware Certifications	0°C to 55°C (32°F to 131°F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003
Intel® X550-T2	Networking Interface	2 x RJ-45
	System Interface	PCI Express 3 x4
	Networking Speeds Supported	100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps
	Cabling (up to 100m)	Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6a (or higher) for 10Gbps
	Power Consumption (active-typical)	3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps
	Physical Dimensions	5.2 in x 2.7 in (without bracket)
	Connect Speed LED Indicators	Link/Activity LED Off = No link Blinking = Activity Speed LED Off = No link Amber = <10Gbps Green = 10Gbps

• Green = 10Gbps

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.

Technical Specifications - Networking and Communications		
	Operating Temperature Hardware Certifications	0°C to 55°C (32°F to 131°F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003
Intel [®] X710-DA2	Networking Interface	2 SFP+ Ports for LC SFP+ Transceivers
10GBASE-SR Converged	System Interface	PCI Express 3.0 x8
Network Adapter	Networking Speeds Supported	1Gbps, 10Gbps
	Cabling	LC fiber optic cabling with LC SFP+ Transceivers
	Power Consumption (active-typical)	4.3W
	Physical Dimensions	6.578 in x 2.703 in
	Connect Speed LED Indicators	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps
	Operating Temperature	0 °C to 55 °C (32 °F to 131 °F)
	Hardware Certifications	USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003
	Note: Windows 7 is NOT s	
10GbE SFP+ SR	Connector Type	LC

10GbE SFP+ SR Transceiver	Connector Type	LC
	Cable Type	62.5/125um or 50/125um (core/cladding), graded-index, low metal content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC 793-2 Type A1b or A1a, respectively.
	Cable Length	2-300m
	Wavelength	850nm
	Form Factor	SFP+
	Physical Dimensions	0.47(h) x 0.54(w) x 2.19(d) inches (1.19 x 1.38 x 5.57 cm)
	Operating Temperature	OC to 45C (32F to 113F)
	Operating Humidity	0% to 85%, noncondensing

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Technical Specifications - Networking and Communications

Intel® 8265 WLAN	Networking Speeds	802.11ac MU-MIMO (up to 867 Mbps) Bluetooth 4.2
	IEEE WLAN Standard	IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending
	Bluetooth	4.2
	System Interface	PCI Express 2.1 x1
	Antenna	2x2

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.
See the Supported Configuration section for supported configurations.

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Summary of Changes

SUMMARY OF CHANGES

Date of change:	Version History:		Description of change:
November 1, 2017	From v1 to v2	Added	HP DisplayPort to HDMI Adapter, NVIDIA SLI 2-slot Graphics Connector and NVIDIA Quadro Sync II to Graphics section
		Changed	Graphics, Storage / Hard Drives and Memory sections, changed Front and internal view info on the Overview section, changed Operating Systems section, changed System Board section, changed System Configuration, DECLARED NOISE EMISSIONS and Physical Security and Serviceability sections
November 29, 2017	From v2 to v3	Added	Processors, hard drives and graphics to offerings, added Intel Xeon W-2195 to Processors section
		Changed	Wattage links on power supply section updated and Voltage links on efficientcy section updated
February 5, 2018	From v3 to v4	Added	Features and Supported Configurations for Intel® Core™ X- Series Processor Family
		Changed	Formatting
February 27, 2018	From v4 to v5	Added	Intel Core i9-X processors footnotes added to processors pre-installed section
March 27, 2018	From v5 to v6	Added	NVIDIA Quadro GP100 16GB Graphics, NVIDIA Quadro GV100 32GB Graphics and AMD Radeon Pro WX 9100 16GB Graphics as High End 3D in Graphics section
August 13, 2018	From v6 to v7	Added	Footnote to Networking and Communications section
		Changed	Operating Systems section
August 24, 2018	From v7 to v8	Changed	Format
September 21, 2018	From v8 to v9	Added	Intel Optane SSD 905p AiC 280GB & 480GB
September 26, 2018	From v9 to v10	Changed	NVIDIA Quadro P6000 Graphics specs
February 11, 2019	From v10 to v11	Added	NVIDIA Quadro RTX 5000 16GB and NVIDIA Quadro RTX 6000 24GB Graphics, added Intel Core i9-9980XE, Intel Core i9-9920X, Intel Core i9- 9820X and Intel Core i7-9800X processors
		Changed	Storage section and Format changes
May 8, 2019	From v11 to v12	Changed	Storage and Graphics sections
June 12, 2019	From v12 to v13	Changed	Storage section
June 24, 2019	From v13 to v14	Changed	RAID Support
July 15, 2019	From v14 to v15	Changed	Corrected Intel 905p Series AIC 480GB PCIe SSD
July 18, 2019	From v15 to v16	Changed	HP SD 4 Card Reader part number
July 23, 2019	From v16 to v17	Changed	Windows 10 Pro High End added to Processors and under Intel Core X- series Processors Preinstalled Power supply-high end section re-arranged
September 1, 2019	From v17 to v18	Added	Footnote to Memory section, Added HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit & module to Storage section, Added Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section
October 26, 2019	From v18 to v19	Changed	Graphics section
November 1, 2019	From v19 to v20	Added	HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and Removable Storage section



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